



# Introduction to digital camera interface (DCMI) for STM32 MCUs

#### Introduction

As the demand for better and better image quality increases, the imaging domain continually evolves giving rise to a variety of technologies (such as 3D, computational, motion, and infrared).

Imaging applications require high-quality, ease-of-use, power efficiency, high level of integration, fast time-to-market, and cost effectiveness. To meet these requirements, the STM32 MCUs embed a digital camera interface (DCMI), which allows connection to efficient parallel camera modules.

The STM32 MCUs provide many performance levels (CPU, MCU subsystem, DSP, and FPU). They also provide various power modes, an extensive set of peripheral and interface combinations (for example, SPI, UART, I<sup>2</sup>C, SDIO, USB, Ethernet, or I2S), a rich graphical portfolio (such as LTDC, QUADSPI, or DMA2D), and an industry-leading development environment ensuring sophisticated applications and connectivity solutions (IoT).

This application note gives to the STM32 users some basic concepts, with easy-to-understand explanations of the features, architecture, and configuration of the DCMI. It is supported by an extensive set of detailed examples.

Refer to the device reference manual and datasheet for more details.

#### Table 1. Applicable products

Туре	STM32 lines and series
	STM32F2x7
	STM32F407/417, STM32F427/437, STM32F429/439, STM32F446, STM32F469/479
	STM32F7x0 value line <sup>(1)</sup> , STM32F7x5, STM32F7x6, STM32F7x7, STM32F7x8, STM32F7x9
	STM32H723/733, STM32H725/735, STM32H730 value line, STM32H742, STM32H743/753, STM32H745/755, STM32H747/757, STM32H750 value line, STM32H7A3/B3
Microcontrollers	STM32L4x6
	STM32L4P5/Q5, STM32L4R5/S5, STM32L4R7/S7, STM32L4R9/S9
	STM32U5 series
	STM32H563/573, STM32H562, STM32H523/533
	STM32N6 series

1. Only STM32F750xx devices.



# 1 General information

This application note applies to the STM32 Series microcontrollers that are Arm<sup>®</sup> Cortex<sup>®</sup> core-based devices.Note:Arm is a registered trademark of Arm Limited (or its subsidiaries) in the US and/or elsewhere.

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# 2 Camera modules and basic concepts

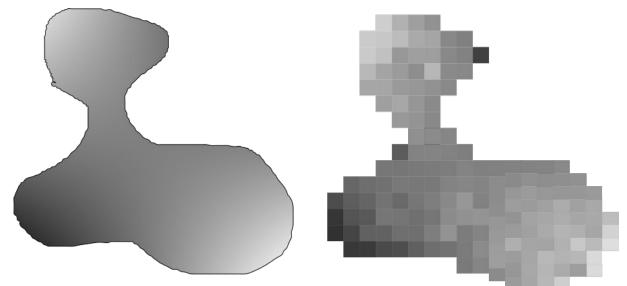
This section provides a summarized description of camera modules and their main components. It also highlights the external interface focusing on parallel camera modules.

### 2.1 Basic imaging concepts

This section introduces the imaging field, and gives an overview of the basic concepts and fundamentals, such as pixel, resolution, color depth, and blanking.

Pixel: each point of an image represents a color for color images, or a gray scale for black-and-white photos

A digital approximation is reconstructed to be the final image. This digital image is a two-dimensional array composed of physical points. Each point is called a pixel (invented from picture elements). In other words, a pixel is the smallest controllable element of a picture. Each pixel is addressable. Figure 1 illustrates the difference between the original image and the digital approximation.



#### Figure 1. Original versus digital image

- Resolution: number of pixels in the image. The more the pixel size increases, the more the image size increases. For the same image size, the higher the number of pixels is, the more details the image contains.
- Color depth (bit depth): the number of bits used to indicate the color of a pixel (is also given in bits per pixel, bpp)
   Examples:
  - For a bitonal image, each pixel comprises one bit. Each pixel is either black or white (0 or 1).
  - For a gray scale, the image is most of the time composed of 2 bpp (each pixel can have one of four gray levels) to 8 bpp (each pixel can have one of 256 gray levels).
  - For color images, the number of bits per pixel varies from 8 to 24 (each pixel can have up to 16777216 possible colors).
- Frame rate (for video): number of frames (or images) transferred each second, expressed in frame per second (FPS).
- Horizontal blanking: ignored rows between the end of one line and the beginning of the next one.

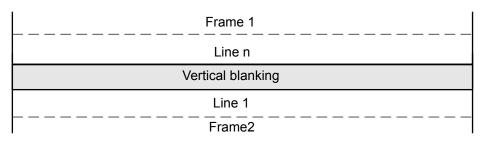
#### Figure 2. Horizontal blanking illustration

Horizontal	Line n (valid data)	Horizontal
blanking	Line n + 1 (valid data)	blanking



• Vertical blanking: ignored lines between the end of the last line of a frame and the beginning of the first line in the next frame.

#### Figure 3. Vertical blanking illustration



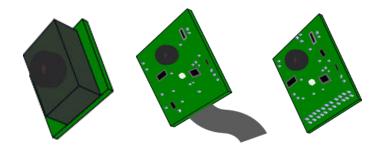
Progressive scan: a manner of dealing with moving images The lines can be drawn one after the other in a sequence without separating the odd lines from the even ones, as for interlaced scan. To construct the image:

- In progressive scan, the first line is drawn, then the second, and, finally, the third
- In interlaced scan, each frame is divided into two fields (odd and even lines), which are displayed alternately

#### 2.2 Camera module

A camera module consists of four parts: image sensor, lens, printed circuit board (PCB), and interface. Figure 4 shows some common camera modules examples.

#### Figure 4. Camera module examples



#### 2.2.1 Camera module components

The four components of a camera module are described below.

#### Image sensor

It is an analog device used to convert the received light into electronic signals. These signals convey the information that constitutes the digital image.

There are two types of sensors that can be used in digital cameras:

- CCD (charge-coupled device) sensors
- CMOS (complementary metal-oxide semiconductor) sensors

Both types convert the light into electronic signals, but each has its own conversion method. As their performance continually evolves and their cost decreases, CMOS imagers now dominate the digital photography landscape.

#### Lens

It is an optic, which allows the reproduction of the real image captured rigorously on the image sensor. Picking the proper lens is part of the user creativity, and affects considerably the image quality.



#### Printed circuit board (PCB)

It is a board that comprises electronic components to ensure the good polarization and the protection of the image sensor. The PCB also supports all the other parts of the camera module.

#### **Camera module interconnect**

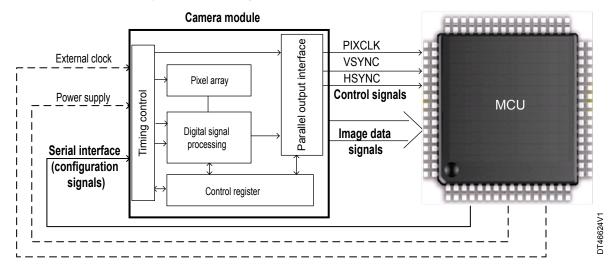
The camera interface is a kind of bridge that allows the image sensor to connect to an embedded system, and to send/receive signals. The following signals are transferred between a camera and an embedded system:

- Control signals
- Image data signals
- Power supply signals
- Camera configuration signals

The camera interfaces are divided into two types: parallel and serial interfaces, depending on the method to transfer data signals.

#### 2.2.2 Camera module interconnect (parallel interface)

As mentioned above, a camera module requires four main types of signals to transmit image data properly: control signals, image data signals, power supply signals, and camera configuration signals. Figure 5 illustrates a typical block diagram of a CMOS sensor, and the interconnection with an MCU.



#### Figure 5. Interfacing a camera module with an STM32 MCU

- Control signals: used for clock generation and data transfer synchronization The camera clock must be provided according to the camera specification. The camera also provides two data synchronization signals: HSYNC (for horizontal/line synchronization) and VSYNC (for vertical/frame synchronization).
- Image data signals: each of them transmits a bit of the image data.
   Their width represents the number of bits to be transferred at each pixel clock. This number depends on the parallel interface of the camera module, and on the embedded system interface.
- Power supply signals: As any embedded electronic system, the camera module needs to have a power supply. The operating voltage of the camera module is specified in its datasheet.
- Configuration signals: used for the following:
  - To configure the appropriate image features such as resolution, format, and frame rate
  - To configure the contrast and the brightness
  - To select the type of interface. (A camera module can support more than one interface: a parallel and a serial interface. The user must then choose the most convenient one for the application.)

Most camera modules are parametrized through an I<sup>2</sup>C communication bus.

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## **3** STM32 DCMI overview

This section gives a general preview of the DCMI availability across the various STM32 devices, and gives an easy-to-understand explanation on the DCMI integration in the STM32 MCUs architecture.

The DCMI is a synchronous parallel data bus, which is used for an easy integration and easy adaptation to specific application requirements. The DCMI connects with 8-, 10-, 12-, and 14-bit CMOS camera modules, and supports a multitude of data formats.

## 3.1 DCMI availability and features across STM32 MCUs

Table 2. Availability of DCMI and related resources summarizes the STM32 devices embedding the DCMI, and highlights the availability of other hardware resources that facilitate the DCMI operation, or that can be used with the DCMI in the same application.

The DCMI applications need a frame buffer to store the captured images. It is then necessary to use a memory destination that varies depending on the image size and the transfer speed.

In some applications, it is necessary to interface with external memories that offer large sizes for data storage. Quad-SPI can be used in this case. For more details, refer to the application note *Quad-SPI interface on STM32 microcontrollers and microprocessors* (AN4760).

The DMA2D (Chrom-ART Accelerator controller) is useful for color space transformation (such as RGB565 to ARGB8888), or for data transfer from one memory to another.

The JPEG codec allows data compression (JPEG encoding) or decompression (JPEG decoding).



#### Table 2. Availability of DCMI and related resources

STM32 line	Max flash memory size	On-chip SRAM (Kbytes)	QUADSPI	остоѕрі	HSPI	XSPI	Max FMC <sup>(1)</sup> SRAM and SDRAM frequency (MHz)	Max DCMI pixel clock input (MHz) <sup>(2)</sup>	JPEG codec	DMA2D	LCD_TFT controller (3)	LCD parallel interface	MIPI DSI host <sup>(5)</sup>	Max AHB frequency (MHz)
STM32F2x7	1 Mbyte	128	No	No	No	No	60	48	No	No	No	No	No	120
STM32F407 STM32F417	1 Mbyte	192	No	No	No	No	60	54	No	No	No	No	No	168
STM32F427 STM32F437	2 Mbytes	256	No	No	No	No	90	54	No	Yes	No	No	No	180
STM32F429 STM32F439	2 Mbytes	256	No	No	No	No	90	54	No	Yes	Yes	No	No	180
STM32F446	512 Kbytes	128	Yes	No	No	No	90	54	No	No	No	No	No	180
STM32F469 STM32F479	2 Mbytes	384	Yes	No	No	No	90	54	No	Yes	Yes	No	Yes	180
STM32F7x0	64 Kbytes	320	Yes	No	No	No	100	54	No	Yes	Yes	No	No	216
STM32F7x5	2 Mbytes	512	Yes	No	No	No	100	54	No	Yes	No	No	No	216
STM32F7x6	1 Mbyte	320	Yes	No	No	No	100	54	No	Yes	Yes	No	No	216
STM32F7x7	2 Mbytes	512	Yes	No	No	No	100	54	Yes	Yes	Yes	No	No	216
STM32F7x8 STM32F7x9	2 Mbytes	512	Yes	No	No	No	100	54	Yes	Yes	Yes	No	Yes	216
STM32H723/733	1 Mbytes	564	No	Yes	No	No	137	110	No	Yes	Yes	No	No	240
STM32H725 STM32H735	1 Mbyte	564	No	Yes	No	No	137	110	No	Yes	Yes	No	No	275
STM32H742 STM32H743 STM32H753	2 Mbytes	864	Yes	No	No	No	125	80	Yes	Yes	Yes	No	No	240
STM32H745 STM32H755	2 Mbytes	864	Yes	No	No	No	125	80	Yes	Yes	Yes	No	Yes	240
STM32H747 STM32H757	2 Mbytes	864	Yes	No	No	No	110	80	Yes	Yes	Yes	No	Yes	240
STM32H730	128 Kbytes	564	No	Yes	No	No	137	110	No	Yes	Yes	No	No	275
STM32H750	128 Kbytes	864	Yes	No	No	No	100	80	Yes	Yes	Yes	No	No	240
STM32H7A3 STM32H7B3	2 Mbytes	1180	No	Yes	No	No	100	80	Yes	Yes	Yes	No	No	280

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STM32 line	Max flash memory size	On-chip SRAM (Kbytes)	QUADSPI	OCTOSPI	HSPI	XSPI	Max FMC <sup>(1)</sup> SRAM and SDRAM frequency (MHz)	Max DCMI pixel clock input (MHz) <sup>(2)</sup>	JPEG codec	DMA2D	LCD_ TFT controller (3)	LCD parallel interface	MIPI DSI host <sup>(5)</sup>	Max AHB frequency (MHz)
STM32L4x6	1 Mbyte	320	Yes	No	No	No	40	32	No	Yes	No	No	No	80
STM32L4R9 STM32L4S9 STM32L4R7 STM32L4R7 STM32L4R5 STM32L4R5 STM32L4S5	2 Mbytes	640	No	Yes	No	No	60	48	No	Yes	Yes	No	Yes	120
STM32L4P5 STM32L4Q5	1 Mbyte	320	No	Yes	No	No	60	48	No	Yes	Yes	No	No	120
STM32U575/585	2 Mbytes	786	No	Yes	No	No	80	64	No	Yes	No	Yes	No	160
STM32U535/545	512 Kbytes	274	No	Yes	No	No	No	64	No	Yes	No	No	No	160
STM32U595/5A5 STM32U599/5A9	4 Mbytes	2514	No	Yes	Yes	No	80	64	No	Yes	Yes	Yes	Yes	160
STM32U5F7/5G7 STM32U5F9/5G9	4 Mbytes	3026	No	Yes	Yes	No	80	64	Yes	Yes	Yes	Yes	Yes	160
STM32H533/523	512 Kbytes	272	No	Yes	No	No	100	100	No	No	No	Yes	No	250
STM32H563/573 STM32H562	2 Mbytes	640	No	Yes	No	No	100	100	No	No	No	Yes	No	250
STM32N6 series	0 Kbytes	4200	No	No	No	Yes	166	100	Yes	Yes	Yes	No	Yes	200

1. FSMC for STM32F2x7, STM32F407/417, STM32L4+, and STM32U5 devices.

2. Refer to the datasheet for the pixel clock frequency (DCMI\_PIXCLK).

3. See the application note AN4861 for more details on the STM32 LTDC peripheral.

4. LCD parallel interface via the FMC parallel interface.

5. Refer to the application note AN4860 for more details on the STM32 MIPI-DSI host.

AN5020 - Rev 4



### 3.2 DCMI in a smart architecture

The DCMI is connected to the AHB bus matrix. It is accessed by the DMA to transfer the received image data. The destination of the received data depends on the application.

The smart architecture of STM32 MCUs allows the following:

- The DMA, as an AHB master, transfers the received data (image number n+1) to the memory, while the CPU processes the previously captured image (image number n).
- The DMA2D, as an AHB master, is used to transfer or modify the received data (CPU resources are kept for other tasks).
- The memories throughput and the performance are improved thanks to the multi-layer bus matrix.

#### 3.2.1 STM32F2 system architecture

The STM32F2x7 devices are based on a 32-bit multi-layer bus matrix, used to interconnect eight masters and seven slaves. The DCMI is a slave AHB2 peripheral. The DMA2 performs the data transfer from the DCMI to internal SRAMs or external memories through the FSMC.

Figure 6 shows the DCMI interconnection and the data path in the STM32F2x7 devices.

#### MAC GP GP OTG HS Cortex-M3 DMA1 DMA2 Eth ≥ £, DMA MEM1 **MEM2** ≥ ŝ Ъ. HERNET DMA S-bus D-bus DMA -bus USB DMA Flash ART memory APB1 APB2 AHB1 periph DCMI VSYNC AHB2 periph ¢ DCMI\_HSYNC DCMI DCMI PIXCLK Bus matrix-S Data[0:13] Pixel path through the DCMI and the DMA Pixel path to the memory destination Bus mutliplexer 32-bit bus width

#### Figure 6. DCMI slave AHB2 peripheral in the STM32F2x7

#### 3.2.2 STM32F4 system architecture

The STM32F407/417, STM32F427/437, STM32F429/439, STM32F446, and STM32F469/479 line devices are based on a 32-bit multilayer bus matrix, allowing the interconnection between:

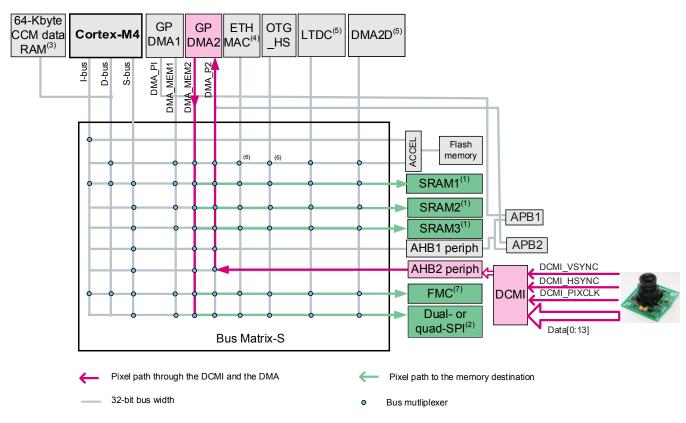
- Ten masters and eight slaves for the STM32F429/439 devices
- Ten masters and nine slaves for the STM32F469/479 devices
- Seven masters and seven slaves for the STM32F446 devices
- Eight masters and seven slaves for the STM32F407/417 devices
- Eight masters and eight slaves for the STM32F427/437 devices

The DCMI is a slave AHB2 peripheral. The DMA2 performs the data transfer from the DCMI to internal SRAMs or external memories through the FMC (FSMC for the STM32F407/417 line) or the QUADSPI.



Figure 7 shows the DCMI interconnection and the data path in these devices.

#### Figure 7. DCMI slave AHB2 peripheral in the STM32F4



#### Note:

1. See the table below for details on the SRAMs.

- 2. The dual- or quad-SPI interface is available only in the STM32F469/479 and STM32F446 devices.
- 3. The 64-Kbyte CCM data RAM is not available in the STM32F446xx devices.
- 4. The Ethernet MAC interface is not available in the STM32F446xx devices.
- 5. The LTDC and DMA2D are only available in the STM32F429/439 and STM32F469/479 devices.
- 6. In the STM32F407/417 devices, there is no interconnection between:
  - The Ethernet master and the DCode bus of the flash memory
  - The USB master and the DCode bus of the flash memory

In the STM32F446 devices, there is no interconnection between the USB master and the DCode bus of the flash memory.

7. It is FMSC for the STM32F407/417 devices.

#### Table 3. SRAM availability in the STM32F4 series

STM32 line	SRAM1 (Kbytes)	SRAM2 (Kbytes)	SRAM3 (Kbytes)
STM32F407/417			N/A
STM32F427/437, STM32F429/439	112	16	64
STM32F446			N/A
STM32F469/479	160	32	128

#### 3.2.3 STM32F7 system architecture

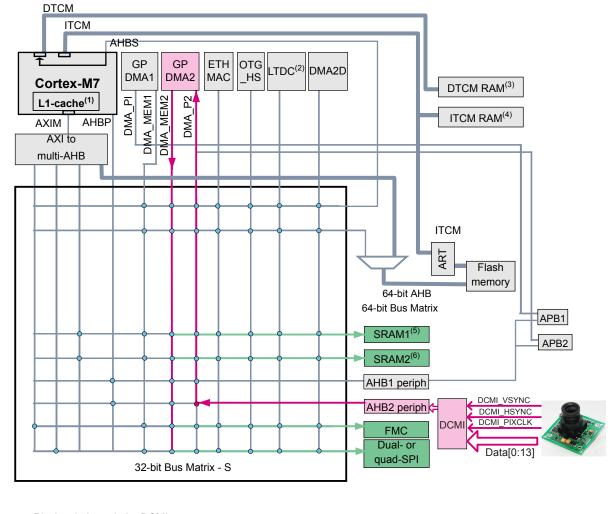
The STM32F7x5, STM32F7x6, STM32F7x7, STM32F7x8, and STM32F7x9 line devices, and the STM32F750 devices in the STM32F7x0 value line are based on a 32-bit multilayer bus matrix, allowing the interconnection between:

- Twelve masters and eight slaves for the STM32F7x6, STM32F7x7, STM32F7x8, STM32F7x9, and STM32F750 devices
- Eleven masters and eight slaves for the STM32F7x5 devices

The DCMI is a slave AHB2 peripheral. The DMA2 performs the data transfer from the DCMI to internal SRAM or external memories through the FMC or the QUADSPI.

Figure 8 shows the DCMI interconnection and the data path in these devices.





 Pixel path through the DCMI — 32-bit bus and the DMA

- Pixel path to the memory
   destination
- 64-bit bus

Note: 1. 7

- 1. The I/D cache size is:
  - 4 Kbytes for the STM32F7x5/F7x6 and STM32F750 devices
  - 16 Kbytes for the STM32F7x7/F7x8/F7x9 devices
- 2. The LTDC is only available in the STM32F7x6/F7x7/F7x8/F7x9 and STM32F750 devices.
- 3. The DTCM RAM size is:
  - 64 Kbytes for the STM32F7x5/F7x6 and STM32F750 devices
  - 128 Kbytes for the STM32F7x7/F7x8/F7x9 devices
- 4. The ITCM RAM size is 16 Kbytes for the STM32F7x6/F7x7/F7x8/F7x9 and STM32F750 devices.
- 5. The SRAM1 size is:
  - 240 Kbytes for the STM32F7x5/F7x6 and STM32F750 devices
  - 368 Kbytes for the STM32F7x7/F7x8/F7x9 devices
- 6. The SRAM2 size is 16 Kbytes for the STM32F7x6/F7x7/F7x8/F7x9 and STM32F750 devices.



#### 3.2.4 STM32H7 system architecture

The STM32H723/733, STM32H743/753, STM32H7A3/B3, STM32H747/757, STM32H745/755, STM32H742, STM32H725/735, STM32H750, and STM32H730 line devices are based on an AXI bus matrix, two AHB bus matrices, and bus bridges allowing the interconnection between:

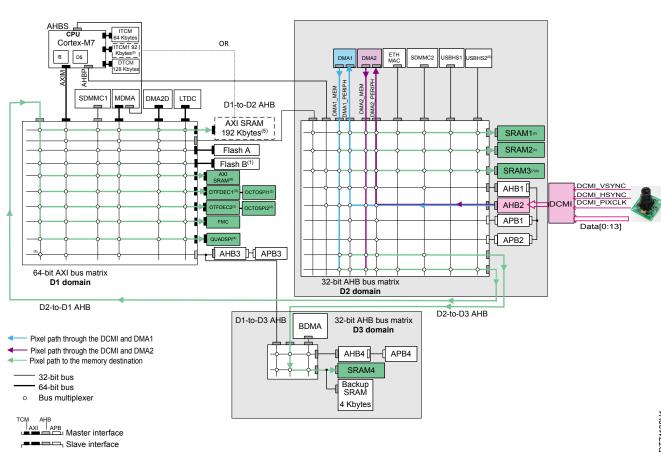
- 23 masters and 18 slaves for the STM32H745/755 and STM32H747/757 devices
- 18 masters and 18 slaves for the STM32H723/733, STM32H725/735, STM32H753, and STM32H730 devices
- 19 masters and 18 slaves for the STM32H742 and STM32H743 devices
- 19 masters and 20 slaves for the STM32H7A3/B3 devices
- 19 masters and 17 slaves for the STM32H750 Value line devices

#### 3.2.4.1 STM32H7x3, STM32H742, STM32H725/735, STM32H730, and STM32H750 devices

The DCMI is a slave AHB2 peripheral. The DMA1 and DMA2 perform the data transfer from the DCMI to internal SRAMs or external memories through the FMC, the QUADSPI, or the OCTOSPI.

The DMA1 and DMA2 are located in the D2 domain. They are able to access the slaves in the D1 and D3 domains. As a result, the DMA1 and DMA2 can transfer the data received by the DCMI (located in D2) to memories located in the D1 or D3 domains.

Figure 9 shows the DCMI interconnection and the data path in these devices.



# Figure 9. DCMI slave AHB2 peripheral in the STM32H723/733, STM32H743/753, STM32H742, STM32H725/735, STM32H730, and STM32H750 devices

Note:

1. Flash B is not available in the STM32H723/733, STM32H725/735, STM32H730, and STM32H750 devices.

2. OCTOSPI1 and 2 are not available in the STM32H743/753, STM32H742, and STM32H750 devices.

3. OTFDEC1 and 2 are only available in the STM32H723/733, STM32H725/735, and STM32H730 devices.

4. The QUADSPI is only available in the STM32H743/753, STM32H742, and STM32H750 devices.

5. The 192-Kbyte AXI SRAM and the 92-Kbyte ITCM are only available in the STM32H723/733, STM32H725/735, and STM32H730 devices.

6. The USBHS2 is only available in the STM32H743/753, STM32H742, and STM32H750 devices.

7. The SRAM3 is only available in the STM32H743/753, STM32H74,2 and STM32H750 devices.

8. There is no connection between the APB3 and the D2 domain in the STM32H723/733, STM32H725/735, STM32H730, and STM32H750 devices.

9. See Table 4 for more details on the SRAM1, SRAM2, SRAM3 and the AXI SRAM.

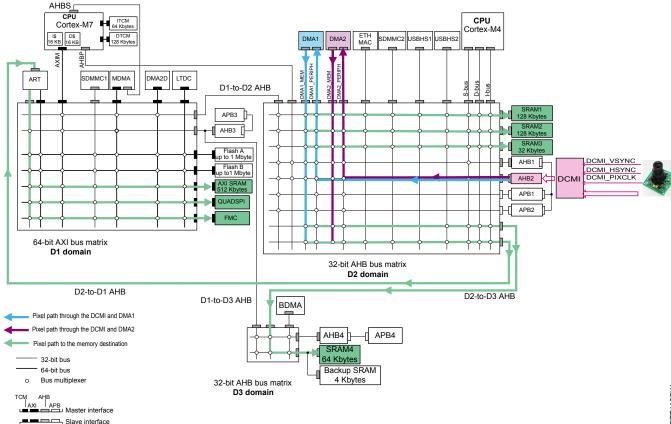


# Table 4. SRAM availability in the STM32H723/733, STM32H743/753, STM32H742, STM32H725/735, STM32H730, and STM32H750 devices

STM32 line	SRAM1 (Kbytes)	SRAM2 (Kbytes)	SRAM3 (Kbytes)	AXI SRAM (Kbytes)
STM32H723/733	16	16	Х	128
STM32H725/735	16	16	Х	128
STM32H730	16	16	Х	128
STM32H743/753	128	128	32	512
STM32H742	128	128	32	512
STM32H750	128	128	32	512

#### 3.2.4.2 STM32H745/755 and STM32H747/757 devices

The DMA1 and DMA2 are in the D2 domain. They are able to access slaves in the D1 and D3 domains. As a result, the DMA1 and DMA2 can transfer the data received by the DCMI (located in D2) to memories located in the D1 or D3 domains. Figure 10 shows the DCMI interconnection and the data path in these devices.

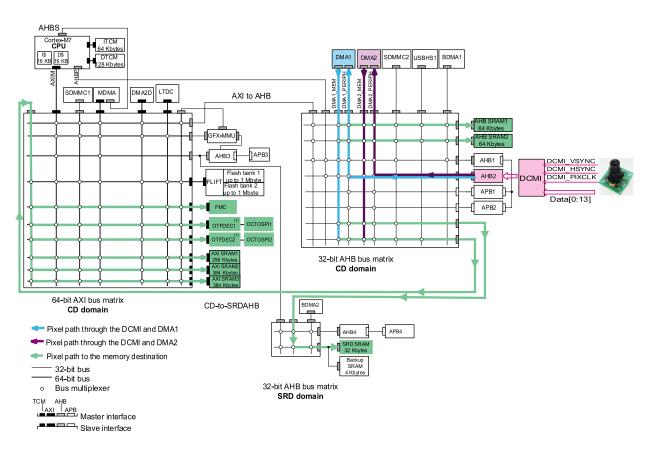


#### Figure 10. DCMI slave AHB2 peripheral in the STM32H745/755 and STM32H747/757 devices

#### 3.2.4.3 STM32H7A3/7B3 devices

The DMA1 and DMA2 are in the CD domain. They are able to access slaves in the CD and SRD domains. As a result, the DMA1 and DMA2 can transfer the data received by the DCMI (located in the CD domain) to memories located in the CD or SRD domain. Figure 11 shows the DCMI interconnection and the data path in these devices.





#### Figure 11. DCMI slave AHB2 peripheral in the STM32H7A3/B3

Note: OTFDEC1/2 are only available in the STM32H7B3 devices.

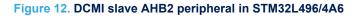
#### 3.2.5 STM32L4 system architecture

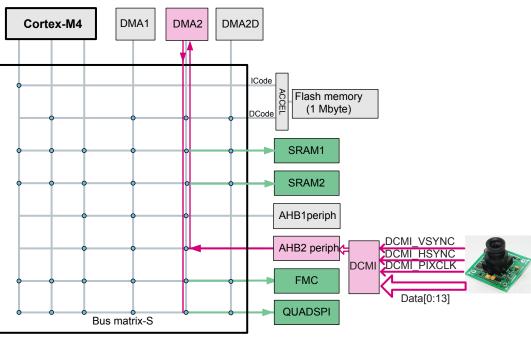
The STM32L496xx and STM32L4A6xx devices are based on a 32-bit multilayer bus matrix, allowing the interconnection between six masters and eight slaves.

The DCMI is a slave AHB2 peripheral. The DMA2 performs the data transfer from the DCMI to internal SRAMs or external memories through the FMC or QUADSPI.

The DMA has only one port (not like STM32F2/F4/F7 and STM32H7 devices where the peripheral port is separated from the memory port), but it supports circular-buffer management, peripheral-to-memory, memory-to-peripheral, and peripheral-to-peripheral transfers.







Pixel path through the DCMI and the DMA
 32-bit bus width
 Bus multiplexer

#### 3.2.6 STM32L4+ system architecture

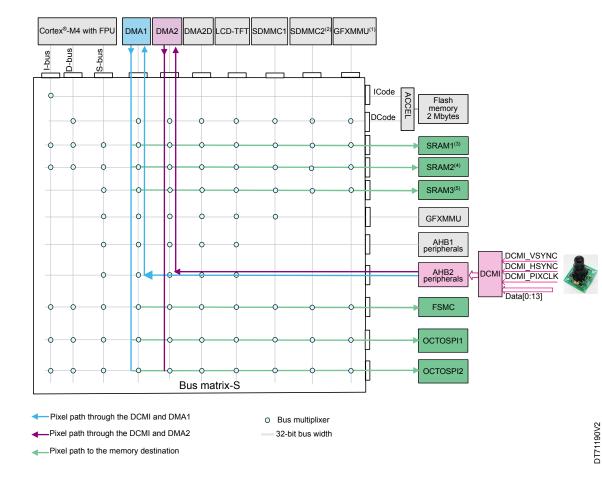
The STM32L4R9/S9, STM32L4R7/S7, STM32L4R5/S5, and STM32L4P5/Q5 line devices are based on a 32-bit multilayer bus matrix, allowing the interconnection between:

- 9 masters and 10 slaves for the STM32L4P5/Q5 devices
- 9 masters and 11 slaves for the STM32L4R5/S5, STM32L4R7/S7, and STM32L4R9/S9 devices

The DCMI is a slave AHB2 peripheral. The DMA1 and DMA2 perform the data transfer from the DCMI to internal SRAMs or external memories through the FSMC or OCTOSPI.

The DMA has only one port. It is different from the STM32F2/F4/F7 and STM32H7 devices where the peripheral port is separated from the memory port. However, it supports circular-buffer management, memory-to-memory, peripheral-to-memory, memory-to-peripheral, and peripheral-to-peripheral transfers.

Figure 13 shows the DCMI interconnection and the data path in these devices.



#### Figure 13. DCMI slave AHB2 peripheral in the STM32L4+

1. The GFXMMU is only available in the STM32L4R5/4R7/4R9/4S5/4S7/4S9 devices.

2. The SDMMC1 is only available in the STM32L4P5/4Q5 devices.

- 3. The SRAM1 size is:
  - 128 Kbytes for the STM32L4P5/4Q5 devices \_
  - \_ 192 Kbytes for the STM32L4R5/4R7/4R9/4S5/4S7/4S9 devices.
- 4. The SRAM2 size is 64 Kbytes for the STM32L4P5/4Q5/R5/4R7/4R9/4S5/4S7/4S9 devices.
- 5. The SRAM3 size is:
  - 128 Kbytes for the STM32L4P5/4Q5 devices \_
  - 384 Kbytes for the STM32L4R5/4R7/4R9/4S5/4S7/4S9 devices \_

#### 3.2.7 STM32U5 system architecture

The STM32U5 devices are based on a 32-bit multilayer AHB bus matrix, enabling the interconnection between:

- 16 masters and 13 slaves in the STM32U595/5A5, STM32U599/5A9, STM32U5F7/5G7, and STM32U5F9/5G9 devices
- 11 masters and 10 slaves in the STM32U575/585 devices
- 9 masters and 7 slaves in the STM32U535/545 devices

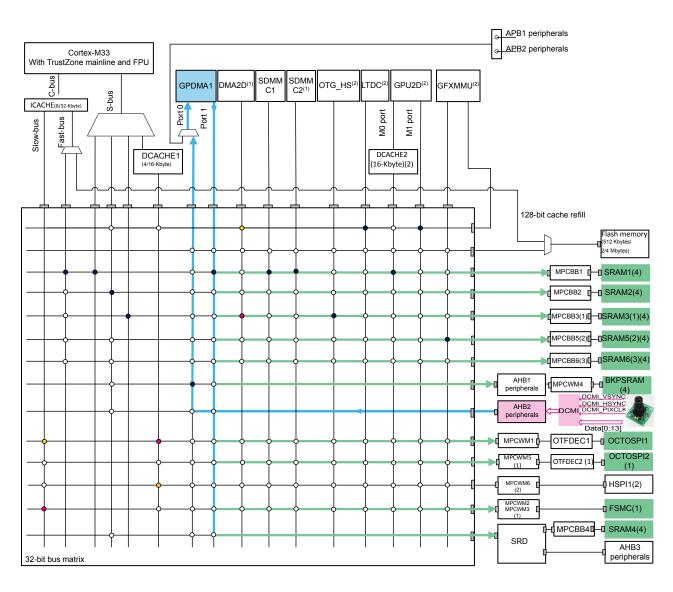
The DCMI is a slave AHB2 peripheral.

The GPDMA1 performs the data transfer from the DCMI to internal SRAMs or external memories through the FSMC, OCTOSPI, or HSPI.

Figure 14 shows the DCMI interconnection and the data path in these devices.

Note:





#### Figure 14. DCMI slave AHB2 peripheral in the STM32U5 devices

Pixel path through the DCMI and GPDMA1 Pixel path to the memory destination

MPCBBx: Block-based memory protection controller

MPCWMx: Watermark-based memory protection controller

o Bus multiplexer

- Fast bus multiplexer •
- Fast bus multiplexer on STM32U59x/5Ax/5Fx/5Gx 0

Fast bus multiplexer on STM32U575/585 •

- Master Interface Slave Interface

DT71616V1

- Note:
- 1. This peripheral is not present in the STM32U535/545.
- 2. This peripheral is not present in the STM32U535/545/575/585.
- 3. This peripheral is present only in the STM32U5F7/5G7, STM32U5F9/5G9.
- 4. See Table 5 for more details on the SRAM1/2/3/4/5/6 and the BKPSRAM

STM32 lines	SRAM1 (Kbytes)	SRAM2 (Kbytes)	SRAM3 (Kbytes)	SRAM4 (Kbytes)	SRAM5 (Kbytes)	SRAM6 (Kbytes)	BKSRAM (Kbytes)
STM32U535/545	192	64	х	16	х	х	2
STM32U575/585	192	64	512	16	х	х	2
STM32U595/5A5 STM32U599/5A9	768	64	832	16	832	x	2
STM32U5F7/5G7 STM32U5F9/5G9	768	64	832	16	832	512	2

#### Table 5. SRAM availability in the STM32U5 devices

#### 3.2.8 STM32H5 system architecture

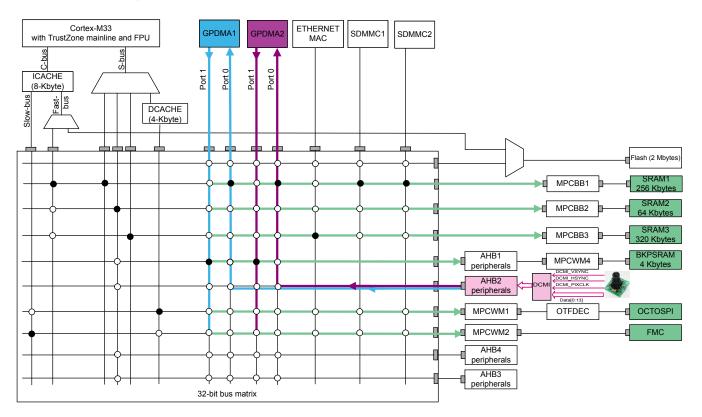
The STM32H562 and STM32H563/573 devices are based on a 32-bit multilayer AHB bus matrix, enabling the interconnection between 13 masters and 10 slaves.

The DCMI is a slave AHB2 peripheral.

The GPDMA1 performs the data transfer from the DCMI to internal SRAMs or external memories through the FMC or OCTOSPI.

Figure 15 shows the DCMI interconnection and the data path in these devices.

#### Figure 15. DCMI slave AHB2 peripheral for the STM32H562 and STM32H563/573



Master Interface

Slave Interface

o Bus multiplexer

• Fast bus multiplexer

MPCBBx: Block-based memory protection controller

MPCWMx: Watermark-based memory protection controller Pixel path through the DCMI and GPDMA1

Pixel path through the DCMI and GPDMA2 Pixel path to the memory destination

DT71617V



#### 3.2.9 STM32N6 system architecture

The STM32N6 devices are based on a 32-bit multilayer AHB bus matrix, enabling the interconnection between 28 masters and 29 slaves.

The DCMI is a slave AHB5 peripheral. The GPDMA performs the data transfer from the DCMI to internal SRAM or external memories through the FMC or the XSPI.



# 4 Reference boards with DCMI and/or camera modules

Many STM32 reference boards are available. Most of them embed the DCMI, and some of them have an onboard camera module. The board selection depends on the application and the hardware resources. The table below summarizes the DCMI, the camera modules, and the memories availability across various STM32 boards.

STM32 line	Board	Camera module	CMOS sensor	Internal SRAM (Kbytes)	External SDRAM bus width (bits)	External SRAM bus width (bits)	
07140050.7	STM3220G-EVAL	<b>X</b> (1)	OV2640 or	400			
STM32F2x7	STM3221G-EVAL	Yes <sup>(1)</sup>	OV9655	132			
	STM32F4DISCOVERY	N/A <sup>(2)(3)</sup>			N	Ά	
STM32F407/417	STM3240G-EVAL	$\mathcal{M}_{\mathbf{r}} = \mathbf{r}(1)$	OV9655	196			
	STM3241G-EVAL	Yes <sup>(1)</sup>					
	32F429IDISCOVERY	N/A <sup>(3)</sup>	N/A		16	N/A	
STM32F429/439	STM32429I-EVAL	$V_{22}(4)$	OV2640 or	256	32	16	
	STM32439I-EVAL	Yes <sup>(4)</sup>	OV9655		52	10	
STM32F446	STM32446E-EVAL	Yes <sup>(5)</sup>	S5k5CAGA	128	16	N/A	
	32F469IDISCOVERY	N/A <sup>(3)</sup>	N/A			N/A	
STM32F469/479	STM32469I-EVAL	$\mathbf{V}_{\mathbf{r}} \mathbf{r}(5)$	SELECACA	388	32	16	
	STM32479I-EVAL	Yes <sup>(5)</sup>	S5k5CAGA			10	
STM32F7x0	STM32F7508DISCOVERY	N/A <sup>(3)</sup>	OV9655	340	32	N/A	
	32F746GDISCOVERY	Yes <sup>(6)</sup>	OV9655		16	N/A	
STM32F7x6	STM32746G-EVAL Yes <sup>(5)</sup> S5k5CAGA 320	22	10				
	STM32756G-EVAL	Yes	SOKOCAGA		32	16	
	32F769IDISCOVERY	N/A <sup>(3)</sup>	N/A			N/A	
STM32F7x9	STM32F769I-EVAL	$\mathbf{V}_{\mathbf{r}} \mathbf{r}(5)$	SELECACA	512	32	10	
	STM32F779I-EVAL	Yes <sup>(5)</sup>	S5k5CAGA			16	
STM32H7x3	STM32H743I-EVAL STM32H753I-EVAL	N/A <sup>(3)</sup>	N/A	864	32	16	
STM32H747/757	STM32H747DISCOVERY	Yes <sup>(7)</sup>	OV5640 or OV9655	868	32	N/A	
STM32H7A3/B3	STM32H7B3I-EVAL	Yes <sup>(8)</sup>	OV5640	1600	32	N/A	
STM32L4x6	32L496GDISCOVERY	Yes <sup>(6)</sup>	OV9655	320			
STM32L4+	32L4R9IDISCOVERY	Yes <sup>(8)</sup>	OV9655	640	- N.	А	
	STM32U575I-EVAL	Yes <sup>(8)</sup>	OV5640	786	N/A	N/A	
	STM32U5F9J-DK1	N/A <sup>(3)</sup>	N/A	3026	N/A	N/A	
STM32U5	STM32U5F9J-DK2	N/A <sup>(3)</sup>	N/A	3026	N/A	N/A	
	STM32U599J-DK		N/A	2514	N/A	N/A	
STM32H573	STM32H573I-DK	N/A <sup>(3)</sup>	N/A	644	16	16	

#### Table 6. DCMI and camera modules on STM32 boards

1. Possible cameras to be connected: module CN01302H1045-C (CMOS sensor OV9655, 1.3 megapixels) and module CN020VAH2554-C (CMOS sensor OV2640, 2 megapixels)

2. N/A means not available. The application must use the desired camera module compatible with the DCMI interface.

3. The camera module can be connected to the DCMI through the GPIO pins.



- 4. The camera module daughterboard MB1066 is connected.
- 5. The camera module daughterboard MB1183 is connected.
- 6. The camera module can be connected to the DCMI through an FFC (flexible flat cable): the STM32F4DIS-CAM can be connected directly.
- 7. The camera module can be connected with caution before powering the Discovery board.
- 8. The camera module daughter board MB1379 is connected.



Note:

# 5 DCMI description

This section details the DCMI, and its manner of dealing with the image data and the synchronization signals. *The DCMI supports only the slave input mode.* 

## 5.1 Hardware interface

The DCMI consists of:

- Up to 14 data lines (D13-D0)
- The pixel clock line DCMI PIXCLK
- The DCMI HSYNC line (horizontal synchronization)
- The DCMI\_VSYNC line (vertical synchronization).

DCMI interrupt ←

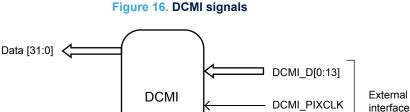
DMA request ←

The DCMI comprises up to 17 inputs. Depending on the number of data lines enabled by the user (8, 10, 12, or 14), the number of the DCMI inputs varies (11, 13, 15, or 17 signals).

If less than 14-bit data width is used, the unused pins must not be assigned to the DCMI through GPIO alternate functions. The unused input pins can be assigned to other peripherals.

In the case of embedded synchronization, the DCMI needs only nine inputs (eight data lines and DCMI\_PIXCLK) to operate properly. The eight unused pins can be used for GPIO or other functions.

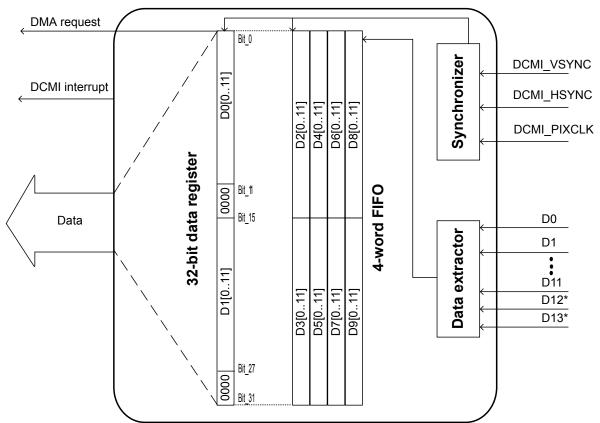
Figure 16 shows the DCMI signals.



DCMI\_HSYNC DCMI\_VSYNC

If x-bit data width is chosen (x data lines are enabled, x = 8, 10, 12, or 14), x bits of image (or video) data are transferred each DCMI\_PIXCLK cycle, and packed into a 32-bit register.





#### Figure 17. DCMI block diagram: example of 12-bit data width

Note: \* D12 and D13 are not used for the 12-bit data width example.

- The DCMI synchronizer ensures the control of the ordered sequencing of the data flow through the DCMI. It controls the data extractor, the FIFO, and the 32-bit register.
- The data extractor ensures the extraction of the data received by the DCMI.
- The 4-word FIFO is implemented to adapt the data rate transfers to the AHB. There is no overrun
  protection to prevent data from being overwritten if the AHB does not sustain the data transfer rate. In case
  of overrun or errors in the synchronization signals, the FIFO is reset, and the DCMI waits for a new start of
  frame.



- A 32-bit data register where the data bits are packed for transfer through a general-purpose DMA channel. The placement of the captured data in the 32-bit register depends on the data width:
  - For an 8-bit data width, the DCMI captures the eight LSBs (the six other inputs D[13:8] are ignored).
     The first captured data byte is placed in the LSB position in the 32-bit word, and the fourth captured data byte is placed in the MSB position. In this case, a 32-bit data word is made up every four pixel clock cycles. For more details, see Section 5.6.

#### Figure 18. Data register filled for 8-bit data width

DCMI_DR	Dn + 3 [7:0]	Dn + 2 [7:0]		Dn+1 [7:0]		Dn [7:0]	
Bit number	31 :	24 23	16	15	8   7		0

 For a 10-bit data width, the DCMI captures the 10 LSBs (the four other inputs D[13:10] are ignored). The first 10 bits captured are placed as the 10 LSBs of a 16-bit word. The remaining MSBs in the 16bit word of the DCMI\_DR register (bits 10 to 15) are cleared. In this case, a 32-bit data word is made up every two pixel clock cycles.

#### Figure 19. Data register filled for 10-bit data width

DCMI_DR	000000	Dn + 1 [9:0]		000000	Dn [9:0]	
Bit number	31 26	25	16	15 10	9	0

 For a 12-bit data width, the DCMI captures the 12-bit LSBs (the two other inputs D[13:12] are ignored). The first 12 bits captured are placed as the 12 LSBs of a 16-bit word. The remaining MSBs in the 16-bit word of the DCMI\_DR register (bits 12 to 15) are cleared. In this case, a 32-bit data word is made up every two pixel clock cycles.

#### Figure 20. Data register filled for 12-bit data width

DCMI_DR	0000	Dn + 1 [11:0]	0000	Dn [11:0]
Bit number	31 28	27 16	15 12	11 0

 For a 14-bit data width, the DCMI captures all the received bits. The first 14 bits captured are placed as the 14 LSBs of a 16-bit word. The remaining MSBs in the 16-bit word of the DCMI\_DR register (bits 14 and 15) are cleared. In this case, a 32-bit data word is made up every two pixel clock cycles.

#### Figure 21. Data register filled for 14-bit data width

DCMI_DR 00	Dn + 1 [13:0]	00	Dn [13:0]	
Bit number 31 30	29 16	15 14	13	0

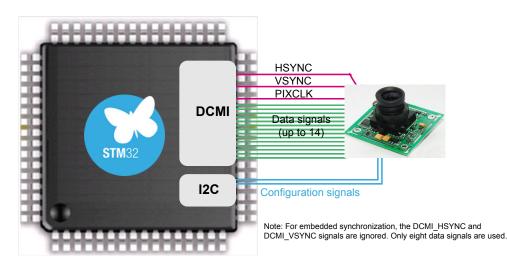


## 5.2 Camera module and DCMI interconnection

As mentioned in Section 2.2.2, the camera module is connected to the DCMI through the following signal types:

- DCMI clock and data signals
- I2C configuration signals

#### Figure 22. STM32 MCU and camera module interconnection



#### 5.3 DCMI functional description

The following steps summarize the internal DCMI component operation, and give an example of data flow through the system bus matrix:

- 1. After receiving the different signals, the synchronizer controls the data flow through the different DCMI components (data extractor, FIFO, and 32-bit data register).
- 2. Being extracted by the extractor, data are packed in the 4-word FIFO, then ordered in the 32-bit register.
- 3. Once the 32-bit data block is packed in the register, a DMA request is generated.
- 4. The DMA transfers the data to the corresponding memory destination.
- 5. Depending on the application, data stored in the memory can be processed differently.

It is assumed that all image preprocessing is performed in the camera module.

#### 5.4 Data synchronization

The camera interface has a configurable parallel data interface from 8 to 14 data lines, together with:

- A pixel clock line, DCMI\_PIXCLK (rising/falling edge configuration)
- A horizontal synchronization line, DCMI\_HSYNC
- A vertical synchronization line, DCMI\_VSYNC, with a programmable polarity
- The DCMI\_PIXCLK and AHB clocks must respect the minimum ratio AHB/DCMI\_PIXCLK of 2.5.

Some camera modules support the two types of synchronization, while others support either the hardware or the embedded synchronization.

#### 5.4.1 Hardware (or external) synchronization

In this mode, the DCMI\_VSYNC and DCMI\_HSYNC signals are used for the synchronization:

- The line synchronization is always referred to as DCMI\_HSYNC (also known as LINE VALID).
- The frame synchronization is always referred to as DCMI\_VSYNC (also known as FRAME VALID).

The polarities of the DCMI\_PIXCLK and the synchronization signals (DCMI\_HSYNC and DCMI\_VSYNC) are programmable.

Data are synchronized with DCMI\_PIXCLK, and change on the rising or falling edge of the pixel clock, depending on the configured polarity.

Note:



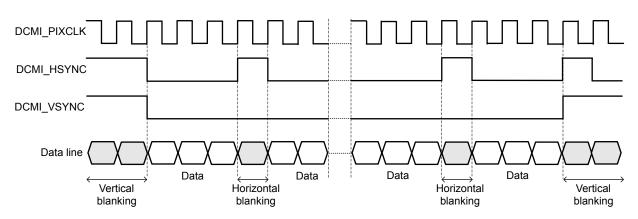
If the DCMI VSYNC and DCMI HSYNC signals are programmed active level (active high or active low), the data is not valid in the parallel interface when VSYNC or HSYNC is at that level (high or low).

For example, if VSYNC is programmed active high:

- When VSYNC is low, the data is valid.
- When VSYNC is high, the data is not valid (vertical blanking).

The DCMI HSYNC and DCMI VSYNC signals act like blanking signals, since all data received during DCMI HSYNC/DCMI VSYNC active periods are ignored.

Figure 23 shows an example of data transfer when DCMI VSYNC and DCMI HSYNC are active high, and when the capture edge for DCMI PIXCLK is the rising edge.



#### Figure 23. Frame structure in hardware synchronization mode

#### **Compressed data synchronization**

For compressed data (JPEG), the DCMI supports only the hardware synchronization. Each JPEG stream is divided into packets, which have programmable size. The packets dispatching depends on the image content, and results in a variable blanking duration between two packets.

DCMI\_HSYNC is used to signal the start/end of a packet. DCMI\_VSYNC is used to signal the start/end of the stream.

If the full data stream finishes and the detection of an end-of-stream does not occur (DCMI VSYNC does not change), the DCMI pads out the end-of-frame by inserting zeros.

#### 5.4.2 Embedded (or internal) synchronization

In this case, delimiter codes are used for synchronization. These codes are embedded within the data flow to indicate the start/end of line or the start/end of frame.

Note: These codes are supported only for 8-bit parallel data interface width. For other data widths, this mode generates unpredictable results, and must not be used.

> The codes eliminate the need for DCMI\_HSYNC and DCMI\_VSYNC to signal the end/start of the line or the frame. When this synchronization mode is used, there are two values that must not be used for data: 0 and 255 (0x00 and 0xFF). These two values are reserved for data identification purposes. It is up to the camera module to control the data values. Image data can then have only 254 possible values (0x00 < image data value < 0xFF). Each synchronization code consists of 4-byte sequence 0xFF 00 00 XY (as shown in Figure 24), where all delimiter codes have the same first 3-byte sequence 0xFF 00 00. Only the final one 0xXY is programmed to indicate the corresponding event.

#### Embeded 0xFF 0x00 0x00 0xXY code DCMI DR ← ———— Common bytes for all codes – $\rightarrow \longleftarrow$ —Variable byte $\rightarrow$

Figure 24. Embedded code bytes



5.4.2.1

#### Mode 1

This mode is ITU656 compatible (ITU656 is the digital video protocol ITU-R BT.656). The following reference codes indicate a set of four events:

- SAV (active line): line-start
- EAV (active line): line-end
- SAV (blanking): line-start during inter-frame blanking period
- EAV (blanking): line-end during inter-frame blanking period

Figure 25 illustrates the frame structure using this mode.

#### Figure 25. Frame structure in embedded synchronization mode 1

SAV (blanking)	Vertical (or frame) blanking	EAV (blanking)	
	DataLine_0		
SAV (active line)		EAV (active line)	Horizontal (or line) blanking
	DataLine_N		
SAV (blanking)	Vertical (or frame) blanking	EAV (blanking)	
Synchronization code Data Blanking			nking

The embedded synchronization codes signal another set of events:

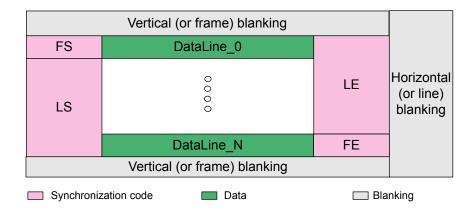
- Frame-start (FS)
- Frame-end (FE)
- Line-start (LS)
- Line-end (LE)

A 0xFF value programmed as a frame-end (FE) means that all the unused codes (the possible values of codes other than FS, LS, LE) are interpreted as valid FE codes.

In this mode, once the camera interface has been enabled, the frame capture starts after the first occurrence of an FE code followed by an FS code.

#### Figure 26 illustrates the frame structure when using this mode.





Note: The camera modules can have up to eight synchronization codes in interleaved mode. This mode is then not supported by the camera interface (otherwise, every other half frame is discarded). When using the embedded synchronization mode, the DCMI does not support the compressed data (JPEG) and the crop feature.

#### 5.4.2.3 Embedded unmask codes

These codes are also used to signal start/end of a line or a frame. Thanks to these codes, instead of comparing all the received code with the programmed one to set the corresponding event, the user can select only some unmasked bits to compare with the bits of the programmed code having the same position.

The user applies a mask to the corresponding code by configuring the DCMI embedded synchronization unmask register (DCMI\_ESUR). Each byte in this register is an unmask code, corresponding to an embedded synchronization code:

- The most significant byte is the frame-end delimiter unmask (FEU): each bit set to 1 implies that this bit, in the frame-end-code, must be compared with the received data to know if it is a frame-end event or not.
- The second byte is the line-end delimiter unmask (LEU): each bit set to 1 implies that this bit, in the lineend-code, must be compared with the received data to know if it is a line-end event or not.
- The third byte is the line-start delimiter unmask (LSU): each bit set to 1 implies that this bit, in the line-startcode, must be compared with the received data to know if it is a line-start event or not.
- The less significant byte is the frame-start delimiter unmask (FSU): each bit set to 1 implies that this bit, in the frame-start-code, must be compared with the received data to know if it is a frame-start event or not.

There can be different codes for each event (line-start, line-end, frame-start, or frame-end) but all of them (the different codes corresponding to one event) have the unmasked bits in the same position (same unmask code). Example: FSC = 0xA5 and unmask code FSU = 0x10 (as shown in Figure 27). In this case the frame-start information is embedded in the bit number 4 of the FS code. The user must compare only the bit number 4 of the received code with the bit number 4 of the programmed code, to know if it is a frame-start event or not.

#### Figure 27. Embedded code unmasking

FSC = 0xA5			1 0 1 0 0 1 0 1
FSU = 0x10			0 0 0 1 0 0 0 0
FSC unmasked bits 11111	1 1 1 1 1 0 0 0 0 0 	0000000000 	0- - - 0- - - - 



Note: Make s

Make sure that each synchronization code has different unmask code to avoid synchronization errors.

#### 5.5 Capture modes

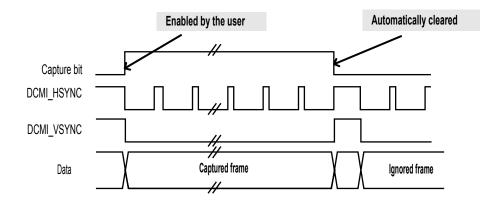
The DCMI supports two types of capture: snapshot (a single frame) and continuous grab (a sequence of frames). The user can control the capture rate by selecting the bytes, lines, and frames to capture in the DCMI\_CR register. These features are used to convert the color format of the image, and/or to reduce the image resolution (by capturing one line out of two, the vertical resolution is divided by 2). For more details, refer to Section 5.8.

#### 5.5.1 Snapshot mode

In this mode, a single frame is captured. After the capture is enabled by setting the CAPTURE bit in DCMI\_CR, the interface waits for the detection of a start of frame (the next DCMI\_VSYNC or the next embedded frame-start code, depending on the synchronization mode) before sampling the data.

Once the first complete frame is received, the DCMI is automatically disabled (CAPTURE bit automatically cleared), and all the other frames are ignored. In case of an overrun, the frame is lost and the camera interface is disabled.

#### Figure 28. Frame reception in snapshot mode



#### 5.5.2 Continuous grab mode

Once this mode is selected and the capture is enabled (CAPTURE = 1), the interface waits for the detection of a start of frame (the next DCMI\_VSYNC or the next embedded frame-start code, depending on the synchronization mode) before sampling the data.

In this mode, the DCMI can be configured to capture all the frames, every alternate frame (50% bandwidth reduction), or one frame out of four (75% bandwidth reduction). The camera interface is not automatically disabled but the user must disable it by setting CAPTURE = 0. After being disabled by the user, the DCMI continues to grab data until the end of the current frame.

# Capture bit Capture bit Coml\_HSYNC DCMI\_HSYNC DCMI\_VSYNC Data Captured frame 1 Captured frame 2 Captured frame N Ignored frame

#### Figure 29. Frame reception in continuous grab mode

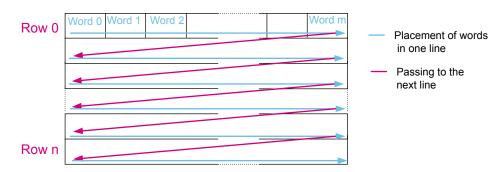
## 5.6 Data formats and storage

The DCMI supports the following data formats:

- 8-bit progressive video: either monochrome or raw Bayer
- YCbCr 4:2:2 progressive video
- RGB565 progressive video
- Compressed data (JPEG)

For monochrome, RGB and YCbCr, the frame buffer is stored in raster mode as shown in Figure 30.

#### Figure 30. Pixel raster scan order



Note: Only 32-bit words are used, and only the little-endian format is supported (the least significant byte is stored in the smallest address).

Data received from the camera can be organized in lines, frames (raw YUV/RGB/Bayer modes), or can be a sequence of JPEG images.

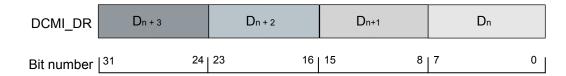
The number of bytes in a line may not be a multiple of four. The user must therefore be careful when handling this case since a DMA request is generated each time a complete 32-bit word has been constructed from the captured data. When an end of frame is detected and the 32-bit word to be transferred has not been completely received, the remaining data are padded with zeros, and a DMA request is generated.



#### 5.6.1 Monochrome

The DCMI supports the monochrome format 8 bpp. In the case an 8-bit data width is selected when configuring the DCMI, the data register has the structure shown in Figure 31.

#### Figure 31. DCMI data register filled with monochrome data



#### 5.6.2 RGB565

RGB refers to Red, Green, and Blue, which represent the three hues of light. Any color is obtained by mixing these three colors.

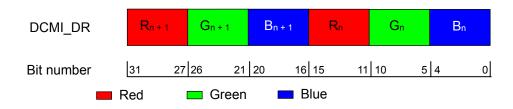
565 is used to indicate that each pixel consists of 16 bits divided as follows:

• 5 bits for encoding the red value (the most significant 5 bits)

- 6 bits for encoding the green value
- 5 bits for encoding the blue value (the less significant 5 bits)

Each component has the same spatial resolution (4:4:4 format): each sample has a red (R), a green (G) and a blue (B) component. Figure 32 shows the DCMI data register containing RGB data, when an 8-bit data width is selected.

#### Figure 32. DCMI data register filled with RGB data



#### 5.6.3 YCbCr

YCbCr is a family of color spaces that separates the luminance or luma (brightness) from the chrominance or chroma (color differences).

YCbCr consists of three components:

- Y refers to the luminance or luma (black and white).
- Cb refers to the blue difference chroma.
- Cr refers to the red difference chroma.

YCbCr 4:2:2 is a subsampling scheme, which requires a half resolution in horizontal direction: for every two horizontal Y samples, there is one Cb or Cr sample.

Each component (Y, Cb, and Cr) is encoded in 8 bits. Figure 33 shows the DCMI data register containing YCbCr data when an 8-bit data width is selected.

# Figure 33. DCMI data register filled with YCbCr data

DCMI_DR	Yn + 1	Crn	Yn	Cbn
Bit number 31	24	23 16	15 8	7 0



#### 5.6.4 YCbCr, Y only

Note:

This data format is only available for the STM32F446, STM32F469/479, STM32F7, STM32H7, STM32L496xx, STM32L4A6, STM32L4+, STM32U5, STM32H5, and STM32N6 devices listed in Table 1.

The buffer contains only the Y information, monochrome image. The chroma information is dropped. Only the luma component of each pixel, encoded in 8 bits, is stored. The result is a monochrome image having the halfhorizontal resolution of the original image (YCbCr data). Figure 34 shows the DCMI register when an 8-bit data width is selected.

#### Figure 34. DCMI data register filled with Y only data

DCMI_DR	<b>Y</b> n + 3	Yn + 2	Yn+1	Yn
Bit number 3	31 24	23 16	15 8	7 0

#### 5.6.5 **JPEG**

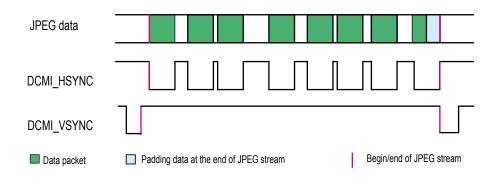
For compressed data (JPEG), the DCMI supports only the hardware synchronization, and the input size is not limited. Each JPEG stream is divided into packets, which have programmable size. The packet dispatching depends on the image content, and results in a variable blanking duration between two packets.

To allow JPEG image reception, the JPEG bit must be set to one in the DCMI CR register. The JPEG images are not stored as lines and frames. The DCMI\_VSYNC signal is used to start the capture while DCMI\_HSYNC serves as a data enable signal.

If the full data stream finishes and the detection of an end of stream does not occur (DCMI VSYNC does not change), the DCMI pads out the end of the frame by inserting zeros: if the stream size is not a multiple of four, at the end of the stream, the DCMI pads the remaining data with zeros.

The crop feature and embedded synchronization mode cannot be used in the JPEG format. Note:

#### Figure 35. JPEG data reception



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#### 5.7 Crop feature

With the crop feature, the camera interface selects a rectangular window from the received image. The start coordinates (upper-left corner) are specified in the 32-bit DCMI\_CWSTRT register.

The window size is specified in number of pixel clocks (horizontal dimension), and in number of lines (vertical dimension) in the DCMI CWSIZE register.



## 5.8 Image resizing (resolution modification)

Note:

This feature is only available for STM32F446, STM32F469/479, STM32F7x5/6/7/8/9, STM32F750, STM32H7, STM32L496xx, STM32L4A6, STM32L4+, STM32U5, STM32H5, and STM32N6 devices listed in Table 1.

As described in Section 5.5, the DCMI capture features are set through the DCMI\_CR register.

The DCMI captures all received lines, or one line out of two (the user can choose to capture the odd or even lines).

This feature affects the vertical resolution that can be received by the DCMI as sent from the camera module or divided by two (only the odd or the even lines are received).

This interface also allows the capture of:

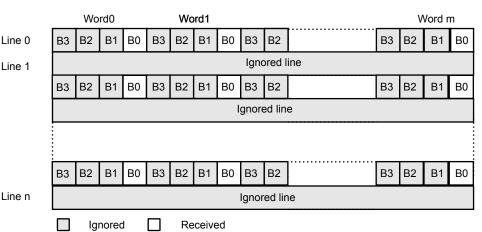
- All received data
- Every other byte from the received data (one byte out of two, only the odd or the even bytes are received)
- One byte out of four
- Two bytes out of four

This feature affects the horizontal resolution allowing the user to select one of the following resolutions:

- The full horizontal resolution
- The half of the horizontal resolution
- The quarter of the horizontal resolution (available only for 8 bpp data formats)

**Caution:** For some data formats (color spaces), the modification of the horizontal resolution allows a change of the data format. For example, when the data format is YCbCr, the data is received interleaved (CbYCrYCbYCr). When the user chooses to receive every other byte, the DCMI receives only the Y component of each sample, means converting YCbCr data into Y-only data. This conversion affects both the horizontal resolution (only half of the image is received), and the data format.

Figure 36 shows one frame when receiving only one byte out of four and one line out of two.



#### Figure 36. Frame resolution modification

#### 5.9 DCMI interrupts

The following interrupts can be generated:

- IT LINE indicates the end of line.
- IT\_FRAME indicates the end of frame capture.
- IT OVR indicates the overrun of data reception.
- IT VSYNC indicates the synchronization frame.
- IT\_ERR indicates the detection of an error in the embedded synchronization code order (only in embedded synchronization mode).

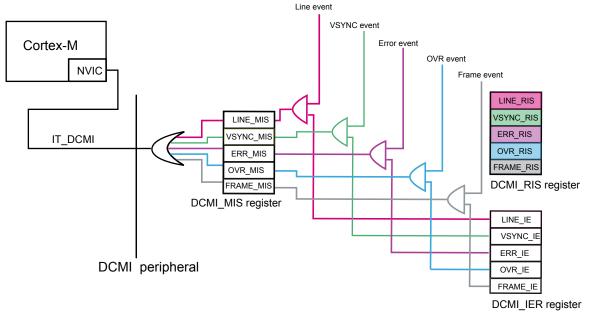
All interrupts can be masked by software. The global interrupt dcmi\_it is the logic OR of all the individual interrupts.



The DCMI interrupts are handled through the following registers:

- DCMI\_IER: read/write register allowing the interrupts to be generated when the corresponding event occurs
- DCMI\_RIS: read-only register giving the current status of the corresponding interrupt, before masking this
  interrupt with DCMI\_IER (each bit gives the status of the interrupt that can be enabled or disabled in
  DCMI\_IER).
- DCMI\_MIS: read-only register providing the current masked status of the corresponding interrupt, depending on DCMI\_IER and DCMI\_RIS.

If an event occurs and the corresponding interrupt is enabled, the DCMI global interrupt is generated.



#### Figure 37. DCMI interrupts and registers

#### 5.10 Low-power modes

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The STM32 power mode has a direct effect on the DCMI, which operates as follows over the different power modes:

- In Run mode, the DCMI and all peripherals operate normally.
- In Sleep mode, the DCMI and all peripherals work normally, and generate interrupts to wake up the CPU.
- In Stop and Standby modes, the DCMI does not work.

For some STM32 devices, there are other low-power modes where the state of the DCMI varies from one to the other:

- Low-power Run mode
- Low-power Sleep mode: interrupts from peripherals cause the device to exit this mode.
- Stop 0, Stop 1, Stop 2, Stop 3 modes: the content of peripheral registers is kept.
- Shutdown mode: the peripheral must be reinitialized when exiting Shutdown mode.

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The table below summarizes the DCMI operation in the different modes.

Mode	DCMI operation
Run	
Low-power Run <sup>(1)</sup>	Active
Sleep	Active
Low-power Sleep <sup>(1)</sup>	
Stop <sup>(2)</sup>	
Stop 0 <sup>(3)</sup>	
Stop 1 <sup>(3)</sup>	
Stop 2 <sup>(3)</sup>	Frozen
Stop 3 <sup>(4)</sup>	
Stop mode SVOS high <sup>(5)</sup>	
Stop mode SVOS low <sup>(5)</sup>	
Standby	Doword down
Shutdown <sup>(3)</sup>	Powered down

1. Only for the STM32L496xx, STM32L4A6xx, and STM32L4+ devices.

2. Not available on the STM32N6 devices.

3. Only for the STM32L496xx, STM32L4A6xx, STM32L4+, and STM32U5 devices.

- 4. Only on the STM32U5 devices.
- 5. Only for the STM32N6 devices.

# 6 DCMI configuration

When selecting a camera module to interface with STM32 MCUs, the user must consider some parameters such as the pixel clock, the supported data format, and the resolutions.

To correctly implement the application, the user needs to perform the following configurations:

- Configure the GPIOs.
- Configure the timings and the clocks.
- Configure the DCMI peripheral.
- Configure the DMA.
- Configure the camera module:
  - Configure the I2C to allow the camera module configuration and control.
  - Set parameters such as contrast, brightness, color effect, polarities, and data format.

Note: It is recommended to reset the DCMI and the camera module before starting the configuration. The DCMI can be reset by setting the corresponding bit in the RCC\_AHB2RSTR register, which resets the clock domains.

### 6.1 GPIO configuration

To easily configure the DCMI GPIOs (such as data pins, control signals pins, camera configuration pins), and to avoid any pin conflicts, it is recommended to use the STM32CubeMX configuration and initialization code generator.

Thanks to the STM32CubeMX, the user generates a project with all the needed peripherals preconfigured. Depending on the extended data mode chosen by configuring EDM bits in DCMI\_CR register, the DCMI receives a 8-, 10-, 12-, or 14-bpp clock (DCMI\_PIXCLK).

The user needs to configure:

- 11, 13, 15, or 17 GPIOs for the DCMI for the hardware synchronization
- only nine GPIOs (eight pins for data and one pin for DCMI\_PIXCLK) for the embedded synchronization

The user needs to configure also the I2C, and in some cases the camera power supply pin (if the camera power supply source is the STM32 MCU).

### Enable interrupts

To be able to use the DCMI interrupts, the user must enable the DCMI global interrupts on the NVIC side. Each interrupt is then enabled separately by enabling its corresponding enable bit in the DCMI\_IER register:

- Only four interrupts (IT\_LINE, IT\_FRAME, IT\_OVR, and IT\_DCMI\_VSYNC) can be used in hardware synchronization mode.
- The five interrupts can be used in embedded synchronization mode.

The software allows the user to check whether the specified DCMI interrupt has occurred or not, by checking the state of the flags.

### 6.2 Clock and timing configuration

### 6.2.1 System clock configuration (HCLK)

It is recommended to use the highest system clock to get the best performance. This recommendation applies also for the frame buffer of the external memory: if an external memory is used for the frame buffer, the clock must be set at the highest allowed speed to get the best memory bandwidth.

#### Examples:

- STM32F4x9xx devices: the maximum system speed is 180 MHz. If an external SDRAM is connected to the FMC, the maximum SDRAM clock is 90 MHz (HCLK/2).
- STM32F7 devices: the maximum system speed is 216 MHz. With this speed and HCLK/2 prescaler, the SDRAM speed exceeds the maximum allowed speed (see datasheets for more details). To get the maximum SDRAM, it is recommended to configure HCLK @ 200 MHz, then the SDRAM speed is set at 100 MHz.





The clock configurations providing the highest performance are the following:

- For STM32F2x7 devices, HCLK @ 120 MHz and SRAM @ 60 MHz
  - For STM32F407/417 devices, HCLK @ 168 MHz and SRAM @ 60 MHz
- For STM32L4x6 devices, HCLK @ 80 MHz and SRAM @ 40 MHz

### 6.2.2 DCMI clock and timing configuration (DCMI\_PIXCLK)

The DCMI pixel clock configuration depends on the configuration of the pixel clock of the camera module. The user must make sure that the pixel clock has the same configuration on the DCMI and the camera module sides. DCMI\_PIXCLK is an input signal for the DCMI used for input data sampling. The user selects either the rising or the falling edge for capturing data by configuring the PCKPOL bit in the DCMI\_CR register.

As explained in Section 5.4, there are two types of synchronization: embedded and hardware. To select the desired synchronization mode for the application, the user needs to configure the ESS bit in DCMI\_CR.

#### 6.2.2.1 DCMI clock configuration in hardware synchronization

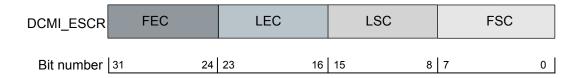
The DCMI\_HSYNC and DCMI\_VSYNC signals are used. The configuration of these two signals is defined by selecting each signal active level (high or low) for the VSPOL and HSPOL bits in DCMI\_CR.

Note: The user must make sure that DCMI\_HSYNC and DCMI\_VSYNC polarities are programmed according to the camera module configuration. In the hardware synchronization mode (ESS = 0 in DCMI\_CR), the IT\_VSYNC interrupt is generated (if enabled), even when CAPTURE = 0 in DCMI\_CR. To reduce the frame capture rate even further, the IT\_VSYNC interrupt can be used to count the number of frames between two captures, in conjunction with the snapshot mode. This is not allowed by the embedded synchronization mode.

#### 6.2.2.2 DCMI clock configuration in embedded synchronization

The line-start/line-end and frame-start/frame-end are determined by codes or markers embedded within the data flow. The embedded synchronization codes are supported only for an 8-bit parallel data interface width. The synchronization codes must be programmed in the DCMI\_ESCR register as defined in Figure 38.

### Figure 38. DCMI\_ESCR register bytes



### FEC (frame-end code)

The most significant byte specifies the frame-end delimiter. The camera module sends a 32-bit word containing 0xFF 00 00 XY with XY = FEC code, to signal the end of a frame. The code is received as indicated in Figure 39.

#### Figure 39. FEC structure



Before the reception of this FEC code, VSYNC must be set to one in DCMI\_SR to indicate a valid frame. After the reception of the FEC, VSYNC must be cleared to zero to indicate that it is synchronization between frames. VSYNC must remain at zero until the reception of the next frame-start code.

If FEC = 0xFF (the camera module sends 0xFF 00 00 FF), all the unused codes are interpreted as frame-end codes. There are 253 values corresponding to the end-of-frame delimiter (0xFF0000FF and the 252 unused codes).



### LEC (line-end code)

This byte specifies the line-end marker. The code received from the camera to indicate the end of line is 0xFF 00 00 XY with XY = LEC code.

### Figure 40. LEC structure



### FSC (frame-start code)

This byte specifies the frame-start marker. The code received from the camera to indicate the start of new frame is 0xFF 00 00 XY with XY = FSC code.





### LSC (line-start code)

This byte specifies the line-start marker. The code received from the camera to indicate the start of new line is 0xFF 00 00 XY with XY = LSC code.

If LSC = 0xFF, the camera module does not send a frame-start delimiter. The DCMI interprets the first occurrence of an LSC code after an FEC code as an FSC code occurrence.

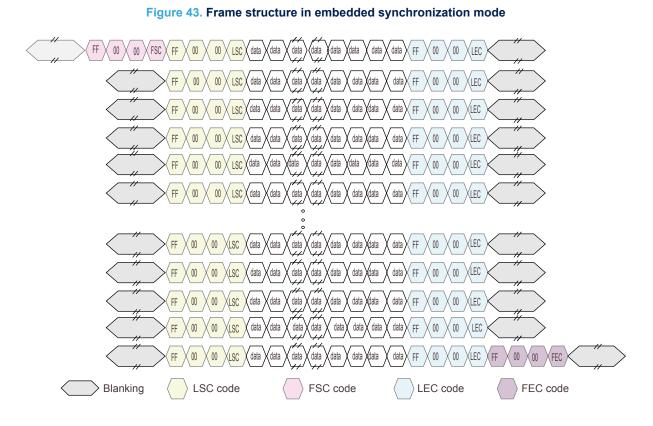
Figure 42. LSC structure



In this embedded synchronization mode, HSPOL and VSPOL bits are ignored. While the DCMI receives data (CAPTURE = 1 in DCMI\_CR), the user can monitor the data flow to know if it is an active line/frame or a synchronization between lines/frames, by reading VSYNC and HSYNC in DCMI\_SR.

If ERR\_IE = 1 in DCMI\_IER, an interrupt is generated each time an error occurs (such as embedded synchronization characters not received in the correct order).

Figure 43 shows a frame received in embedded synchronization mode.



## 6.3 DCMI configuration

The DCMI configuration allows the user to select the capture mode, the data format, the image size, and the resolution.

### 6.3.1 Capture mode selection

The user can capture an image or a video by selecting one of the following modes:

- The continuous grab mode to capture frames (images) continuously
- The snapshot mode to capture a single frame

The received data in snapshot or continuous grab mode is transferred to the memory frame buffer by the DMA. The buffer location and mode (linear or circular buffer) are controlled through the system DMA.

### 6.3.2 Data format selection

The DCMI allows the reception of compressed data (JPEG) or many uncompressed data formats (such as monochrome, RGB, or YCbCr). For more details, refer to Section 5.6.

### 6.3.3 Image resolution and size

The DCMI allows the reception of a wide range of resolutions (low, medium, high) and image sizes, since the image size depends on the image resolution and data format. The DMA ensures the transfer and the placement of the received images in the memory frame buffer.

Optionally, the user can configure the byte, line, and frame select mode to modify the image resolution and size, and in some cases, the data format (see Section 5.8). The user can also configure and enable the crop feature to select a rectangular window from the received image (see Section 5.7).

Note: The DCMI configuration registers must be programmed correctly before enabling the ENABLE bit in DCMI\_CR. The DMA controller and all DCMI configuration registers must be programmed correctly before enabling the CAPTURE bit in DCMI\_CR.



### 6.4 DMA configuration

The DMA configuration is a crucial step to ensure the success of the application.

As mentioned in Section 3.2, the DMA2 ensures the transfer from the DCMI to the memory (internal SRAM or external SRAM/SDRAM) for all STM32 devices embedding the DCMI.

For the STM32H7 and SMT32L4+ devices, the DMA1 can also access the AHB2 peripherals and ensures the transfer of the received data from the DCMI to the memory frame buffer.

For the STM32U5 and STM32N6 devices, the GPDMA1 ensures the transfer from the DCMI to the memory. For the STM32H5 devices, the GPDMA1 and the GPDMA2 ensure the transfer from the DCMI to the memory.

### 6.4.1 DMA configuration for DCMI-to-memory transfers

The transfer direction must be peripheral-to-memory by configuring:

- DIR bits in DMA\_SxCR for the STM32F2, STM32F4, STM32F7, and STM32H7 devices
- DIR bits in DMA\_CCRx for the STM32L4x6 and STM32L4+ devices
- SWREQ = 0 and REQSEL[6:0] in GPDMA\_CxTR2 for the STM32U5 and STM32H5

The source address (DCMI data register address) must be written:

- In DMA\_SxPAR for the STM32F2, STM32F4, STM32F7, and STM32H7 devices
- In DMA\_CPARx for the STM32L4x6 and STM32L4+ devices
- In GPDMA\_CxSAR for the STM32U5, STM32H5, and STM32N6 devices

The destination address (frame buffer address in internal SRAM or external SRAM/SDRAM) must be written:

- In DMA\_SxMAR for the STM32F2, STM32F4, STM32F7, and STM32H7 devices
- In DMA\_CMARx for the STM32L4x6 and STM32L4+ devices
- In GPDMA\_CxDAR for the STM32U5, STM32H5, and STM32N6 devices

To ensure the data transfer from the DCMI data register, the DMA waits for the request to be generated from the DCMI. The relevant stream and channel must be configured. For more details, refer to Section 6.4.3.

Since a DMA request is generated each time the DCMI data register is filled, the data transferred from the DCMI must have a 32-bit width. Data is transferred:

- To the DMA2 (or the DMA1 for the STM32H7 and STM32L4+ devices) for all STM32 except for the STM32U5, STM32H5, and STM32N6
- To the GPDMA1 for the STM32U5, STM32H5, and STM32N6 devices
- To the GPDMA2 for the STM32H5 devices

The peripheral data width must be 32-bit words. It is programmed:

- By PSIZE bits in DMA\_SxCR for the STM32F2, STM32F4, STM32F7, and STM32H7 devices
- By PSIZE bits in DMA\_CCRx register for the STM32L4x6 and STM32L4+ devices
- By DDW LOG2 and DBL 1 in GPDMA CxTR1 for the STM32U5, STM32H5, and STM32N6 devices

The DMA is the flow controller: the number of 32-bit data words to be transferred is software programmable from 1 to 65535 (see Section 6.4.4 for more details):

- In DMA\_SxNDTR for the STM32F2, STM32F4, STM32F7, and STM32H7 devices
- In DMA\_CNDTRx for the STM32L4x6 and STM32L4+ devices
- In GPDMA\_CxBr1 for the STM32U5, STM32H5, and STM32N6 devices

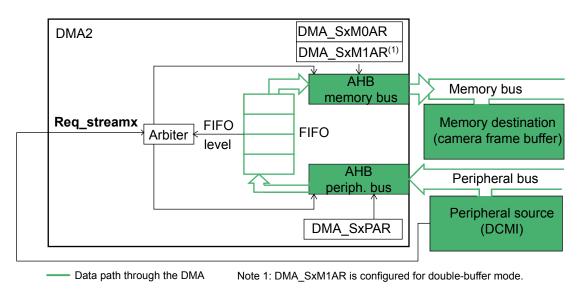
The DMA operates in one of the following modes:

- Direct mode: each word received from the DCMI is transferred to the memory frame buffer.
- FIFO mode: the DMA uses its internal FIFO to ensure burst transfers (more than one word from the DMA FIFO to the memory destination).

For more details on the DMA internal FIFO, refer to Section 6.4.5.



Figure 44 shows the DMA2 (or the DMA1 for STM32H7 and STM32L4+ devices, the GPDMA1 for the STM32U5, and STM32N6 devices, the GPDMA1 or the GPDMA2 for the STM32H5 devices) operation in peripheral-tomemory mode, except for the STM32L496xx and STM32L4A6xx devices. The DMA2 in these devices has only one port.



### Figure 44. Data transfer through the DMA

6.4.2 DMA configuration versus image size and capture mode

The DMA must be configured according to the image size (color depth and resolution), and to the capture mode:

- In snapshot mode, the DMA must ensure the transfer of one frame (image) from the DCMI to the desired memory:
  - If the image size in words does not exceed 65535, the stream can be configured in normal mode (see Section 6.4.6).
  - If the image size in words is between 65535 and 131070, the stream can be configured in doublebuffer mode (see Section 6.4.8).
  - If the image size in words exceeds 131070, the stream cannot be configured in double-buffer mode (see Section 6.4.9).
- In continuous mode: the DMA must ensure the transfer of successive frames (images) from the DCMI to the desired memory. Each time the DMA finishes the transfer of one frame, it starts the transfer of the next frame:
  - If one image size in words does not exceed 65535, the stream can be configured in circular mode (see Section 6.4.7).
  - If one image size in words is between 65535 and 131070, the stream can be configured in doublebuffer mode (see Section 6.4.8).
  - If one image size in words exceeds 131070, the stream cannot be configured in double-buffer mode (see Section 6.4.9).

### 6.4.3 DCMI channel and stream configuration

The user must also configure the corresponding DMA2 (or the DMA1 for the STM32H7 and STM32L4+ devices, the GPDMA1 for the STM32U5 and STM32N6 devices, the GPDMA1 and GPDMA2 for the STM32H5 devices) stream and channel to ensure the DMA acknowledgment each time the DCMI data register is fulfilled.

The tables below summarize the DMA stream and channels that enable the DMA request from the DCMI.

STM32	DMA stream	Channel	
STM32F2			
STM32F4	Stream 1 and stream 7	Channel 1	
STM32F7			
STM32H7	Stream 0 to stream 7	Multiplexer 1 request 75	
STM32L4	Stream 0	Channel 6	
	Stream 4	Channel 5	

### Table 8. DMA stream selection across STM32 devices

### Table 9. DMA stream selection across STM32 devices

	STM32	DMA channel	Request		
STM32L4+	32L4+ STM32L4Rxxx and STM32L4Sxxx Channel 1 to channel 7				DMA request multiplexer 90
31WJ2L4+			DMA request multiplexer 91		
STM32U5		Channel 0 to channel 15	GPDMA1 request 86		
STM32H5		Channel 0 to channel 7 GPDMA1/2 request 108			
STM32N6		Channel 0 to channel 15	GPDMA1 request 140		

Note: See the reference manual for a step-by-step description of the stream and channel configuration procedure.

### 6.4.4 DMA\_SxNDTR/DMA\_CNDTRx/GPDMA\_CxBR1 register

The total number of words to transfer from the DCMI to the memory is programmed in this register (see Section 6.4.1).

When the DMA starts the transfer from the DCMI to the memory, the number of items decreases from the initial programmed value until the end of the transfer (reaching zero or disabling the stream by software before the number of data remaining reaches zero).

The table below gives the number of bytes corresponding to the programmed value and the peripheral data width (PSIZE bitfield).

Table 10. Maximum number of bytes tr	ransferred during one DMA transfer
--------------------------------------	------------------------------------

Programmed value in the register	Peripheral size	Number of bytes
65535	Words	262140
0 < N < 35535	Words	4 * N

Note:

To avoid data corruption, this programmed value must be a multiple of MSIZE or PSIZE.



### 6.4.5 FIFO and burst transfer configuration

The DMA performs the transfer with or without enabling the 4-word FIFO. When the FIFO is enabled, the source data width (programmed in PSIZE) can differ from the destination data width (programmed in MSIZE). In this case, the user must pay attention to adapt the address to write:

- In DMA\_SxPAR and DMA\_SxM0AR (and DMA\_SxM1AR in case of double-buffer mode configuration) to the data width programmed in PSIZE and MSIZE of DMA\_SxCR for all STM32 except the STM32L4/L4+, STM32U5, STM32H5, and STM32N6 devices
- In DMA\_CPARx and DMA\_CMARx to the data width programmed in PSIZE and MSIZE of DMA\_CCRx for the STM32L4 and STM32L4+ devices
- In GPDMA\_CxSAR and GPDMA\_CxDAR to the data width programmed with a burst length by SBL\_1[5:0] (respectively DBL\_1[5:0]), and with a data width defined by SDW\_LOG2[1:0] (respectively DDW\_LOG2[1:0]) in GPDMA\_CxTR1 for the STM32U5, STM32H5, and STM32N6 devices

For a better performance, it is recommended to use the FIFO. When the FIFO mode is enabled, the user can configure the MBURST bits to make the DMA perform burst transfer (up to four words) from its internal FIFO to the destination memory, which guarantees better performance.

### 6.4.6 Normal mode for low resolution in snapshot capture

Low-resolution images are the ones having size (in 32-bit word) less than 65535. In snapshot mode, the normal mode can be used to ensure the transfer of low-resolution frames (see Table 10).

The maximum number of pixels depends on the bit depth of the image (number of bytes per pixel). The DCMI supports two possible bit depths:

- 1 byte per pixel in monochrome or Y only format
- 2 bytes per pixel in case of RGB565 or YCbCr format

The table below summarizes the maximum image resolution that can be transferred using the normal mode.

ltem	Max number of bytes	Bit depth (byte/pixel)	Max number of pixels	Max resolution
Word	Word 262140	1	262140	720x364
word		2	131070	480x272

#### Table 11. Maximum image resolution in normal mode

### 6.4.7 Circular mode for low resolution in continuous capture

The circular mode allows the process of successive frames (continuous data flows), providing that one frame size is less than 65535. The initial size value is programmed:

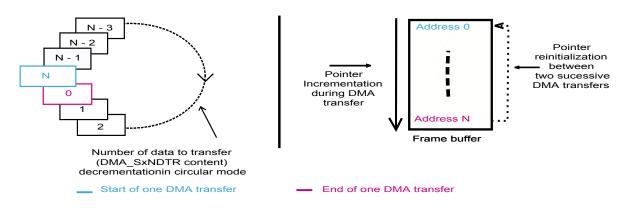
- In DMA\_SxNDTR for the STM32F2, STM32F4, STM32F7, and STM32H7 devices
- In DMA\_CNDTRx for the STM32L4x6 and STM32L4+ devices
- In GPDMA\_CxBr1 for the STM32U5, STM32H5, and STM32N6 devices

Each time the number of data decrementing reaches the zero, the number of data words is automatically reloaded to the initial value. Each time the DMA pointer reaches the end of the frame buffer, it is reinitialized, and the DMA ensures the transfer of the next frame.

The resolutions listed in Table 11 are also valid for the low resolution in continuous mode.



Figure 45 shows the DMA\_SxNDTR value and the frame buffer pointer modifications during a DMA transfer and between two successive DMA transfers.



### Figure 45. Frame buffer and DMA\_SxNDTR register in circular mode

### 6.4.8 Double-buffer mode for medium resolutions (snapshot or continuous capture)

Note:

### This mode is not available for STM32L4A6xx and STM32L496xx devices.

Medium resolution images are the ones with a size (in 32-bit words) between 65536 and 131070. When the double-buffer mode is enabled, the circular mode is automatically enabled.

If the image size exceeds (in words) the maximum sizes mentioned in Table 11 in snapshot or continuous capture, the double-buffer mode must be used in snapshot or continuous mode. In this case, the number of pixels per frame allowed is doubled since received data are stored in two buffers: each buffer maximum size (in 32-bit words) is 65535 (the maximum frame size is 131070 words or 524280 bytes). The images sizes and resolutions allowed to be received by the DCMI and transferred by the DMA are then doubled.

Item	Max number of bytes	Bit depth (byte/ pixel)	programmed value in the register	Number of pixels	Max resolution
		1	65535	524280	960x544
Word 524280	504000		0 < N < 65535	8 * N	900x344
	524260	2	65535	262140	720-264
			0 < N < 65535	4 * N	720x364

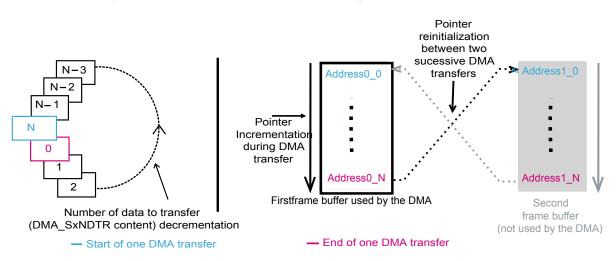
#### Table 12. Maximum image resolution in double-buffer mode

In this mode, the double-buffer stream has two pointers (two buffers for storing data), switched at each end of the transaction:

- In snapshot mode, the DMA controller writes the data to the first frame buffer. After this first frame buffer is filled (at this level, the register is reinitialized to the programmed value, and the DMA pointer switches to the second frame buffer), the data is transferred to the second buffer. The total frame size (in words) is divided by two and programmed into the register. The image is stored to two buffers with the same size.
- In continuous mode, each time one frame (image) is received and stored to the two buffers. As the circular mode is enabled, the register is reinitialized to the programmed value (total frame size divided by two), and the DMA pointer switches to the first frame buffer to receive the next frame.



Figure 46 shows the two pointers and the DMA\_SxNDTR value modifications during the DMA transfers.



#### Figure 46. Frame buffer and DMA\_SxNDTR register in double-buffer mode

### 6.4.9 DMA configuration for higher resolutions

When the number of words in one frame (image) in snapshot or continuous mode exceeds 131070, and when the image resolution exceeds the indicated ones in Table 12, the DMA double-buffer mode cannot ensure the transfer of the received data.

Note: This section highlights only the DMA operation in case of high resolution. An example is developed and described using this DMA configuration in Section 8.3.6: Resolution capture (YCbCr data format).

The STM32F2, STM32F4, STM32F7, STM32H7, and STM32L4+ devices embed a very important feature in double-buffer mode: the possibility to update the programmed address for the AHB memory port on-the-fly (in DMA\_SxM0AR or DMA\_SxM1AR) when the stream is enabled. The following conditions must be respected:

- When CT is cleared to zero in DMA\_SxCR (current target memory is memory 0), the DMA\_SxM1AR
  register can be written. Attempting to write to this register while CT = 1 generates an error flag (TEIF), and
  the stream is automatically disabled.
- When CT is set to one in DMA\_SxCR (current target memory is memory 1), the DMA\_SxM0AR register can be written. Attempting to write to this register while CT = 0 generates an error flag (TEIF), and the stream is automatically disabled.

To avoid any error condition, it is advised to change the programmed address as soon as the TCIF flag is asserted. At this point, the targeted memory must have changed from memory 0 to memory 1 (or from 1 to 0), depending on the CT bit value in DMA\_SxCR.

Note: For all the other modes than the double-buffer one, the memory address registers are write-protected as soon as the stream is enabled.

The DMA allows then the management of more than two buffers:

- In the first cycle, while the DMA uses the buffer 0 addressed by pointer 0 (memory 0 address in DMA\_SxM0AR), the buffer 1 is addressed by pointer 1 (memory 1 address in DMA\_SxM1AR).
- In the second cycle, while DMA uses the buffer 1 addressed by pointer 1, the buffer 0 address can be changed, and the frame buffer 2 can be addressed by pointer 0.
- In the second cycle, while the DMA is using the buffer 2 addressed by pointer 0, the frame buffer 1 address can be changed, and the buffer 3 can be addressed by pointer 1.

DMA\_SxM0AR and DMA\_SxM1AR can then be used to address many buffers, ensuring the transfer of high resolution images.

# Note: To simplify the use of this specific feature, it is recommended to divide the image into equal buffers. When capturing high resolution images, the user must secure that the memory destination has a sufficient size.

**Example**: In case of a resolution that is 1280x1024, the image size is 655360 words (32 bits). This size must be divided into equal buffers, with a maximum size of 65535 for each of them. To be correctly received, the image must then be divided into 16 frame buffers, with each frame buffer size equal to 40960 (lower than 65535).

### Figure 47 illustrates the DMA\_SxM0AR and DMA\_SxM1AR update during the DMA transfer:

### Figure 47. DMA operation in high resolution case

<u>Cycle 0</u>	DMA	A_SxM0AR	DMA_	_SxM1AR				
	Address 0	Address 1	Address 2	Address 3			Address 14	Address 15
CT=0	Buffer 0 = Memory 0	Buffer 1 = Memory 1	Buffer 2	Buffer 3		I	Buffer 14	Buffer 15
<u>Cycle 1</u>	DN	/IA_SxM0A	R DMA	A_SxM1AR				
	Address 0	Address 1	Address 2	Address 3			Address 14	Address 15
CT=1	Buffer 0	Buffer 1 = Memory 1	Buffer 2 = Memory 0	Buffer 3			Buffer 14	Buffer 15
<u>Cycle 2</u>		DMA_S	xM0AR	DMA_SxM	11AR			
	Address 0	Address 1	Address 2	Address 3			Address 14	Address 15
CT=0	Buffer 0	Buffer 1	Buffer 2 = Memory 0	Buffer 3 = Memory 1		ł	Buffer 14	Buffer 15
• • •					[	DMA_SxM	10AR [	DMA_SxM1AR
<u>Cycle 14</u>					L			
	Address 0	Address 1	Address 2	Address 3	T			4 Address 15
CT=0	Buffer 0	Buffer 1	Buffer 2	Buffer 3			Buffer 14 = Memory (	Buffer 15 = ) Memory 1
		Current	buffer DM	A destinatio	n			



### 6.5 Camera module configuration

The following steps allow a correct configuration of the camera module (refer also to the camera module datasheet):

- 1. Configure the input/output functionalities for camera configuration pins to be able to modify its registers (serial communication, mostly I<sup>2</sup>C).
- 2. Apply hardware reset on the camera module.
- 3. Initialize the camera module:
  - Configure the image resolution.
  - Configure the contrast and the brightness.
  - Configure the white balance of the camera (such as black and white, white negative, white normal).
  - Select the camera interface (some camera modules have serial and parallel interface).
  - Select the synchronization mode if the camera module supports more than one.
  - Configure the clock signals frequencies.
  - Select the output data format.



# 7 Power consumption and performance

### 7.1 Power consumption

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In order to save more energy when the application is in low-power mode, it is recommended to put the camera module in low-power mode before the STM32 entry in low-power mode.

Putting camera module in low-power mode ensures a considerable gain in power consumption.

Example for OV9655 CMOS sensor:

- In active mode, the operating current is 20 mA.
- In standby mode, the current requirements drop to 1 mA in case of I2C-initiated Standby mode (the internal circuit activity is suspended but the clock is not halted), and to 10 µA in case of pin-initiated Standby mode (the internal device clock is halted and all internal counters are reset). For more details, refer to the camera datasheet.

### 7.2 Performance

For all STM32 MCUs, the number of bytes to be transferred at each pixel clock depends on the extended data mode:

- When the DCMI is configured to receive 8-bit data, the camera interface takes four pixel clock cycles to capture a 32-bit data word.
- When the DCMI is configured to receive 10-, 12-, or 14-bit data, the camera interface takes two pixel clock cycles to capture a 32-bit data word.

The table below summarizes the maximum data flow depending on the data width configuration.

### Table 13. Maximum data flow at maximum DCMI\_PIXCLK

These values are calculated for the maximum DCMI\_PIXCLK given in Table 2. Availability of DCMI and related resources.

	Data flow (max Mbyte/s) in extended data mode				
STM32	8-bit 1 byte per PICXCLK	10-bit 1.25 bytes per PICXCLK	12-bit 1.5 bytes per PICXCLK	14-bit 1.75 bytes per PICXCLK	
STM32F2	46.875	58.594	70.312	82.031	
STM32F4	52.734	65.918	79.101	92.285	
STM32F7	52.754	05.910	79.101	92.200	
STM32H723/733, STM32H743/753, STM32H747/757, STM32H745/755, STM32H742, STM32H750, STM32H7A3/7B3	78.125	97.656	117.187	136.718	
STM32H725/735, STM32H730	107.422	134.277	161.133	187.988	
STM32L4	31.25	39.062	46.875	54.687	
STM32L4+	46.875	58.594	70.312	82.031	
STM32U5	62.5	78.125	93.75	109.375	
STM32H5	93.75	117.187	140.625	164.062	
STM32N6	90.70	117.107	140.025	104.002	

In some applications, the DMA2 (or the DMA1 for the STM32H7 and STM32L4+; the GPDMA1 for the STM32U5 and STM32N6; and the GPDMA1 and GPDMA2 for the STM32H5) is configured to serve other requests in parallel with the DCMI request. In this case, the user must pay attention to the stream priority configurations, and consider the performance impact when the DMA serves other streams in parallel with the DCMI.

For better performance, when using the DCMI in parallel with other peripherals having requests that can be connected to either DMA1 or DMA2, or to GPDMA1 and GPDMA2, it is better to configure these streams to be served by the DMA/GPDMA that is not serving the DCMI.

The user must make sure that the DCMI supports the pixel clock configured on the camera module side to avoid the overrun.

It is recommended to use the highest system speed HCLK for better performance. However, the user must consider the speed of all the peripherals used (for example the speed of external memories) to avoid an overrun and to ensure the successful operation of the application.

The DCMI is not the only AHB peripheral but there are many other peripherals. The DMA is not the only master that can access the AHB peripherals. Using many AHB peripherals or other masters accessing the AHB peripherals leads to a concurrency on the AHB: the user must consider its impact on performance.



# 8 DCMI application examples

This section details how to use the DCMI, and provides step-by-step implementation examples .

### 8.1 DCMI use cases

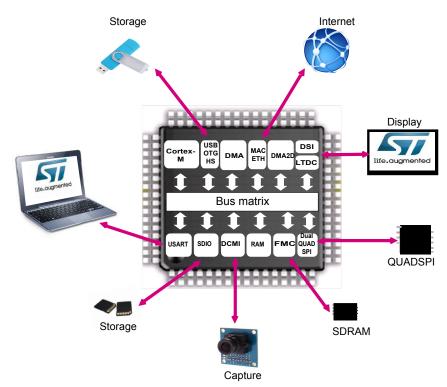
There are several imaging applications that can be implemented using the DCMI and other STM32 peripherals. Here below some application examples:

- Machine vision
- Toys
- Biometry
- Security and video surveillance
- Door phone and home automation
- Industrial monitoring systems and automated inspection
- System control
- Access control systems
- Bar-code scanning
- Video conferencing
- Drones
- Real-time video streaming and battery-powered video cameras

Figure 48 provides examples of applications based on an STM32 MCU. These applications allow the user to:

- Capture data
- Store it to internal or external memories
- Display it
- Share it via the internet
- Communicate with human beings

#### Figure 48. STM32 DCMI application example





### 8.2 STM32Cube examples

The STM32CubeF2, STM32CubeF4, STM32CubeF7, STM32CubeH7, STM32CubeL4, and STM32CubeU5 MCU Packages offer a large set of examples implemented and tested on the corresponding boards.

The table below gives an overview of the DCMI examples and applications across various STM32Cube. All these examples are developed to capture RGB data. For most of the examples, the user can select one of the following resolutions: QQVGA 160x120, QVGA 320x240, 480x272, VGA 640x480.

MCU Package	Project name	Board
	DCMI_CaptureMode	
STM32CubeF2	SnapshotMode	STM3220G-EVAL, STM3221G-EVAL
	Camera_To_USBDisk	
	DCMI_CaptureMode	
STM32CubeF4	SnapshotMode	STM32446E-EVAL, STM32429I-EVAL1, STM32469I-EVAL, STM3240G-EVAL
	Camera_To_USBDisk	
	DCMI_CaptureMode	
	SnapshotMode	STM32756G-EVAL, STM32F769I-EVAL
STM32CubeF7	Camera_To_USBDisk	
	Camera	STM32F7508-DISCOVERY
	DCMI_CaptureMode	
STM32CubeH7	SnapshotMode	STM32H747I-DISCOVERY
	DCMI_CaptureMode	32L496GDISCOVERY, 32L4R9IDISCOVERY
STM32CubeL4	SnapshotMode	
	DCMI_Preview	32L496GDISCOVERY
STM32CubeU5	DCMI_ContinousCap_EmbeddedSynchMode	STM32U575I-EVAL

### Table 14. STM32Cube DCMI examples

### 8.3 DCMI examples based on STM32CubeMX

This section details the following typical examples of DCMI use:

- Capture and display of RGB data Data captured in RGB565 format with QVGA (320 × 240) resolution, stored in the SDRAM, and displayed on the LCD-TFT
- Capture of YCbCr data
   Data captured in YCbCr format with QVGA (320 × 240) resolution and stored in the SDRAM
- Capture of Y-only data DCMI configured to receive Y-only data to be stored in the SDRAM
- Resolution capture (YCbCr data format)
   Data captured in YCbCr format with a 1280 × 1024 resolution and stored in the SDRAM
- Capture of JPEG data Data captured in JPEG format, and stored in the SDRAM

All these examples have been implemented on 32F746GDISCOVERY using STM32F4DIS-CAM (OV9655 CMOS sensor), except the capture of JPEG data that was implemented on STM324x9I-EVAL (OV2640 CMOS sensor).



As illustrated in Figure 49, the application consists of three main steps:

- 1. Import the received data from the DCMI to the DMA (to be stored in FIFO temporarily) through its peripheral port.
- 2. Transfer the data from the FIFO to the SDRAM.
- 3. Import data from the SDRAM to be displayed on the LCD-TFT, only for the RGB data format. For the YCbCr or JPEG data format, the user must convert the received data to RGB to be displayed.

### RGB Cortex-M7 DMA2D DMA2 FIEO 1-Cache life.augmented Bus matrix Pixel data signal reception from the camera module FLASH RAM Dual рсмі FMC QUADSP 1 Mbyte 320 kbyte Frame buffer in the SDRAM Camera SDRAM

### Figure 49. Data path in capture and display application

DT46668V1

For these examples, the user needs to configure the DCMI, the DMA2, the LTDC (for the RGB data capture and display example), and the SDRAM.

The five examples described in the next sections have some common configurations based on STM32CubeMX:

- GPIO configuration
- DMA configuration
- Clock configuration

The following specific configurations are needed for Y-only and JPEG capture examples:

- DCMI configuration
- Camera module configuration

The next sections provide the hardware description, the common configuration using STM32CubeMX, and the common modifications that have to be added to the STM32CubeMX generated project.





### 8.3.1 Hardware description

All examples except the JPEG capture, were implemented on 32F746GDISCOVERY using the camera board STM32F4DIS-CAM, as shown in Figure 50.

### Figure 50. 32F746GDISCOVERY and STM32F4DIS-CAM interconnection



The STM32F4DIS-CAM board includes an Omnivision CMOS sensor (ov9655), 1.3 megapixels. The resolution can reach 1280x1024. This camera module is connected to the DCMI via a 30-pin FFC.

The 32F746GDISCOVERY board features a 4.3-inch color LCD-TFT with capacitive touch screen that is used in the first example to display the captured images.

As shown in Figure 51, the camera module is connected to the STM32F7 through:

- Control signals DCMI\_PIXCLK, DCMI\_VSYNC, DCMI\_HSYNC
- Image data signals DCMI\_D[0..7]

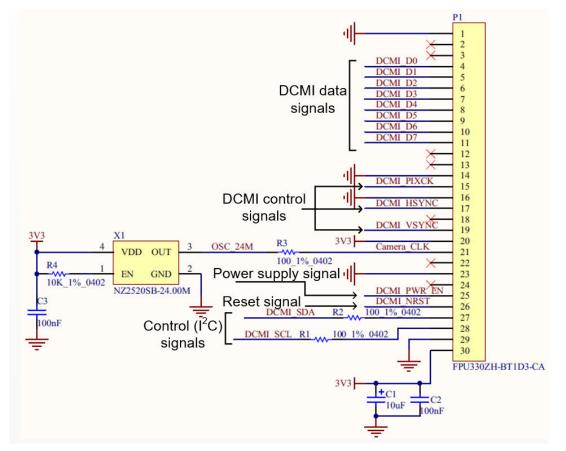
Additional signals are provided to the camera module through the 30-pin FFC:

- Power supply signals (DCMI\_PWR\_EN)
- Clock for the camera module (Camera\_CLK)
- Configuration signals (I2C)
- Reset signal (DCMI\_NRST)

For more details on these signals, refer to Section 2.2.2: Camera module interconnect (parallel interface).

The camera clock is provided to the camera module through the Camera\_CLK pin, by the NZ2520SB crystal clock oscillator (X1) embedded on the 32F746GDISCOVERY board. The frequency of the camera clock is equal to 24 MHz.

The DCMI reset pin (DCMI\_NRST) used to reset the camera module is connected to the global MCU reset pin (NRST).



### Figure 51. Camera connector on 32F746GDISCOVERY

For more details on the 32F746GDISCOVERY board, refer to the user manual *Discovery kit for STM32F7 series* with STM32F746NG MCU (UM1907) available on the STMicroelectronics website.

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Figure 52 details the camera module connector implemented on STM32F4DIS-CAM.

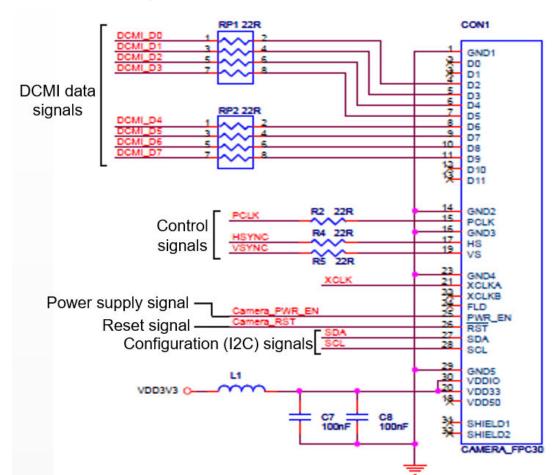


Figure 52. Camera connector on STM32F4DIS-CAM

### 8.3.2 Configuration of common examples

When starting with STM32CubeMX, the first step is to configure the project location and the corresponding toolchain or IDE (menu *Project/Settings*).





8.3.2.1

#### STM32CubeMX - Configuration of DCMI GPIOs

1. Select the DCMI and choose "Slave 8 bits External Synchro" in the Pinout & configuration multimedia tab to configure the DCMI in slave 8-bit external (hardware) synchronization.

### Figure 53. STM32CubeMX - DCMI synchronization mode selection

Pinout & Configuration		Clock Configuration	
		✓ Software Packs	✓ Pinout
۹ 🔍 🕲		DCMI Mode and Configuration	
Categories A->Z		Mode	
System Core >	DCMI Slave 8 bits External Synchro		~
Analog >			
Timers >			
Connectivity >			
Multimedia ~			
¢ DCMI			

If, after selecting one hardware configuration (*Slave 8 bits External Synchro* for example), the used GPIOs do not match with the hardware, the user can change the desired GPIOs, and configure the alternate function directly on the pin.

Another method consists of configuring manually the GPIO pins by selecting the right alternate function for each of them. For more details on the GPIOs that must be configured, refer to Figure 55. After this step, 11 pins must be highlighted in green (D[0..7], DCMI\_VSYNC, DCMI\_HSYNC, and DCMI\_PIXCLK).

- 2. Select the *Configuration* tab to configure the GPIOs mode.
- 3. When the DCMI configuration window appears, select the GPIO Settings tab.

#### Figure 54. STM32CubeMX - GPIO settings selection

	Pino	ut & Configuration	Cloc	k Configuration		
				✓ Software Packs		Pinout
Q	~ 🔕		DCMI Mode and Configuration			1
Categories A->2	Z		Mode			
System Core	>	DCMI Slave 8 bits External Synchro			$\sim$	
Analog	>					
Timers	>					
Connectivity	>					
Multimedia	~					
♠ DCMI ✓ DMA2D						
Ø I2S1						
1282			Configuration			
<ul> <li>I2S3</li> <li>LTDC</li> </ul>						1
Ø SAI1		Reset Configuration				
🔥 SAI2		📀 Parameter Settings 🛛 📀 User Constants	🥺 NVIC Settings 🛛 🤡 DMA	Settings 🛛 🛇 GPIO Settings		
SPDIFRX						



### 4. Select all the DCMI pins.

Pin Name 🗢	Signal on Pin	GPIO output I	GPIO mode	GPIO Pull-up/	Maximum out	User Label	Modified
PA4	DCMI_HSYNC	n/a	Alternate Fun	No pull-up an	Low	DCMI_HSYNC	<b>V</b>
PA6	DCMI_PIXCLK	n/a	Alternate Fun	No pull-up an	Low		
PD3	DCMI_D5	n/a	Alternate Fun	No pull-up an	Low	DCMI_D5	<b>V</b>
PE5	DCMI_D6	n/a	Alternate Fun	No pull-up an	Low	DCMI_D6	<b>V</b>
PE6	DCMI_D7	n/a	Alternate Fun	No pull-up an	Low	DCMI_D7	<b>V</b>
PG9	DCMI_VSYNC	n/a	Alternate Fun	No pull-up an	Low	DCMI_VSYNC	<b>V</b>
PH9	DCMI_D0	n/a	Alternate Fun	No pull-up an	Low	DCMI_D0	<b>V</b>
PH10	DCMI_D1	n/a	Alternate Fun	No pull-up an	Low	DCMI_D1	<b>V</b>
PH11	DCMI_D2	n/a	Alternate Fun	No pull-up an	Low	DCMI_D2	<b>V</b>
PH12	DCMI_D3	n/a	Alternate Fun	No pull-up an	Low	DCMI_D3	<b>V</b>
PH14	DCMI_D4	n/a	Alternate Fun	No pull-up an	Low	DCMI_D4	

#### Figure 55. STM32CubeMX - DCMI pin selection

5. Set the GPIO pull-up/pull-down.

### Figure 56. STM32CubeMX - GPIO no pull-up and no pull-down selection

GPIO Pull-up/Pull-down

No pull-up and no pull-down

### 8.3.2.2 STM32CubeMX - Configuration of DCMI control signals and capture mode

1. Click on Parameter Settings tab in DCMI Configuration window.

#### Figure 57. STM32CubeMX - Parameter Settings tab

<u>^</u>	
🔥 DCMI	Configuration
	· · · · · · · · · · · · · · · · · · ·
⊘ <u>HDMI_CEC</u>	Reset Configuration
Ø 12S1	
12S2	📀 Parameter Settings 🛛 🛇 User Constants 📄 🛇 NVIC Settings 🖉 DMA Settings 🖉 GPIO Settings
G 1999	

2. Set the different parameters (vertical synchronization, horizontal synchronization, and pixel clock polarities) that must be programmed according to the camera module configuration.

Mode Config	
Pixel clock polarity	Active on Rising edge
Vertical synchronization polarity	Active High
Horizontal synchronization polarity	Active Low
Frequency of frame capture	All frames are captured
JPEG mode	Disabled
<ul> <li>Interface Capture Config</li> </ul>	
Byte Select Mode	Interface captures all received bytes
Line Select Mode	Interface captures all received lines

### Figure 58. STM32CubeMX - DCMI control signals and capture mode

Note:

The vertical synchronization polarity must be active high, and the horizontal synchronization polarity must be active low. They must not be inverted for this configuration of the camera module.



### 8.3.2.3 STM32CubeMX - Enable DCMI interrupts

1. Select NVIC Settings tab in DCMI Configuration window, and check the DCMI global interrupt.

#### Figure 59. STM32CubeMX - Configuration of DCMI interrupts

🤡 Parameter Settings	🥝 User Constants	⊘ NVIC	Settings	۵	DMA Settings	🔮 GPIO Setting	IS
NVIC I	nterrupt Table		Enable	d	Preempti	on Priority	Sub Priority
DCMI global interrupt				5		0	

### 8.3.2.4 STM32CubeMX - DMA configuration

This configuration aims to receive RGB565 data (2 byte/pixel). The image resolution is QVGA (320x240). The image size is then  $320 \times 240 \times 2 = 153600$  bytes.

Since the data width sent from the DCMI is 4 bytes (32-bit words sent from the DCMI data register), the number of data items in the DMA\_SxNDTR register is the number of words to transfer. The number of words is then 38400 (153600 / 4) which is less than 65535.

In snapshot mode, the user can configure the DMA in normal mode. In continuous mode, the user can configure the DMA in circular mode.

1. Select DMA Settings tab in DCMI Configuration window.

#### Figure 60. STM32CubeMX - DMA Settings tab

	Configuration								
Reset Configuration									
📀 Parameter Settings	📀 User Constants	⊗ NVIC Settings	OMA Settings	Settings Setting Setting Settings Settings Settings Settings Seti					

2. Click on the Add button.

### Figure 61. STM32CubeMX - Add button



3. Click on *Select* under DMA Request, and choose DCMI. The DMA2 Stream 1 channel 1 is configured to transfer the DCMI request each time its time register is fulfilled.

### Figure 62. STM32CubeMX - DMA stream configuration

DMA Request	Stream	Direction	Priority
DCMI	DMA2 Stream 1	Peripheral To Memory	High



### 4. Modify the DMA Request Settings.

### Figure 63. STM32CubeMX - DMA configuration

DMA Request Settings			
		Peripheral	Memory
Mode Circular ~	Increment Address		
Use Fifo 🗹 Threshold Full 🗸	Data Width	Word $\vee$	Word ~
	Burst Size	Single $\vee$	4 Increment $\sim$

### 8.3.2.5 STM32CubeMX - Camera module power-up pins

To power up the camera module, the PH13 pin must be configured for 32F746GDISCOVERY.

1. Click on the PH13 pin and select GPIO\_Output in the *Pinout* tab.

2.	12. 12	1
10_1		WC.
	Reset_State	
0 G	CAN1_TX	AF
	FMC D21	٩.
	LTDC G2	1
:D_C	TIM8 CH1N	AF B
	GPIO_Input	
D_G	GPIO_Output	AF
	GPIO Analog	
in 6	EVENTOUT	AF
	GPIO_EXTI13	
0.00		1

### Figure 64. STM32CubeMX - PH13 pin configuration

2. In Pinout & Configuration tab system core, click on the GPIO button.

Figure 65. STM32CubeMX - GPIO button





### 3. Set the parameters.

PH13 Configuration :		
GPIO output level	Low	$\sim$
GPIO mode	Output Push Pull	$\sim$
GPIO Pull-up/Pull-down	No pull-up and no pull-down	$\sim$
•		
Maximum output speed	High	$\sim$
User Label	DCMI PWR_EN	
User Laber		
·		

### Figure 66. STM32CubeMX - DCMI power pin configuration

### 8.3.2.6 STM32CubeMX - System clock configuration

In this example, the system clock is configured as follows:

HSE

- Use of an external HSE clock, where the main PLL is used as a system source clock
- HCLK @ 200 MHz, so the Cortex<sup>®</sup>-M7 and LTDC are both running at 200 MHz
- Note: HCLK is set to 200 MHz but not 216 MHz, to set the SDRAM\_FMC at its maximum speed of 100 MHz with an HCLK/2 prescaler.
  - 1. Select the Clock Configuration tab.

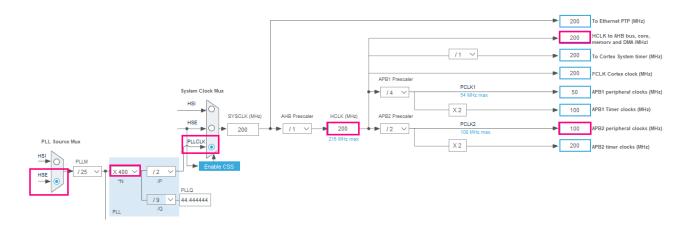
### Figure 67. STM32CubeMX - HSE configuration

Pinout & Configuration	С	lock Con	figuration	
	5	È	3	Resolve CI
Input frequency				



2. Set the PLLs and the prescalers in the Clock Configuration tab, to get the system clock HCLK @ 200 MHz.

### Figure 68. STM32CubeMX - Clock configuration



### 8.3.2.7 Adding files to the project

Generate the code and open the generated project using the preferred toolchain. Then follow these steps:

- 1. Right click on Drivers/STM32F7xx\_HAL\_Driver.
- 2. Choose "Add Existing Files to group 'Drivers/STM32F7xx\_HAL\_Driver..."
- 3. Select the following files in Drivers/STM32F7xx\_HAL\_Driver/Src:
  - stm32f7xx\_hal\_dma2d.c
  - stm32f7xx\_hal\_ltdc.c
  - stm32f7xx\_hal\_ltdc\_ex.c
  - stm32f7xx\_hal\_sdram.c
  - stm32f7xx\_hal\_uart.c
  - stm32f7xx\_ll\_fmc.c
- 4. Create a new group called, for example, Imported\_Drivers.
- 5. Copy the following files from the STM32746G\_Discovery folder in C: directory to the Src folder of the project:
  - stm32746g\_discovery.c
  - stm32746g\_discovery\_sdram.c
- Copy the following files from the STM32746G\_Discovery folder in C: directory to the Inc folder of the project:
  - stm32746g discovery.h
  - stm32746g discovery sdram.h
- 7. Copy ov9655.c from the Components folder to the Src folder.
- 8. Copy ov9655.h from the Components folder to the Inc folder.
- 9. Copy camera.h from the Component/Common folder to the Inc folder.
- 10. Add the following files in the new group (called Imported\_Drivers in this example):
  - stm32746g discovery.h
  - stm32746g\_discovery\_sdram.h
  - ov9655.c
- 11. Allow modifications on ov9655.h and camera.h (read-only by default):
  - a. Click right on the file.
  - b. Uncheck read-only.
  - c. Click on Apply and OK.

12. Modify ov9655.h by replacing #include "../Common/camera.h" by #include "camera.h".



13. Copy the following files to the Inc folder:

- rk043fn48h.h from Components folder
- fonts.h from Utilities/Fonts folder

14. Copy fonts24.c from Utilities/Fonts folder to the Src folder.

15. Check that no problem happened by rebuilding all files. There must be no error and no warning.

### 8.3.2.8 Modifications in main.c file

1. Update main.c by inserting some instructions to include the needed files in the adequate space (indicated in bold below). This task provides the project modification and regeneration without losing the user code.

```
/* USER CODE BEGIN Includes */
#include "stm32746g_discovery.h"
#include "stm32746g_discovery_sdram.h"
#include "ov9655.h"
#include "rk043fn48h.h"
#include "fonts.h"
/* USER CODE END Includes */
```

Some variable declarations must then be inserted in the adequate space indicated in bold below.

```
/* USER CODE BEGIN PV */
/* Private variables -----*/
typedef enum
CAMERA OK = 0 \times 00,
CAMERA ERROR = 0 \times 01,
CAMERA TIMEOUT = 0 \times 02,
CAMERA_NOT_DETECTED = 0 \times 03,
CAMERA NOT SUPPORTED = 0 \times 04
} Camera StatusTypeDef;
typedef struct
uint32 t TextColor;
uint32 t BackColor;
sFONT *pFont;
}LCD_DrawPropTypeDef;
typedef struct
int16_t X;
int16 t Y;
}Point, * pPoint;
static LCD_DrawPropTypeDef DrawProp[2];
LTDC HandleTypeDef hltdc;
LTDC LayerCfgTypeDef layer cfg;
static RCC_PeriphCLKInitTypeDef periph_clk_init_struct;
CAMERA DrvTypeDef *camera driv;
/* Camera module I2C HW address */
static uint32 t CameraHwAddress;
/* Image size */
uint32_t Im_size = 0;
/* USER CODE END PV */
```

The function prototypes must also be inserted in the adequate space indicated in bold below.

```
/* USER CODE BEGIN PFP */
/* Private function prototypes ------*/
uint8_t CAMERA_Init(uint32_t);
static void LTDC_Init(uint32_t, uint16_t, uint16_t, uint16_t, uint16_t);
void LCD_GPIO_Init(LTDC_HandleTypeDef *, void *);
/* USER CODE END PFP */
```



- 2. Update main () function by inserting some functions in the adequate space (indicated in bold below).
  - LTDC\_Init allows the configuration and initialization of the LCD.
  - BSP\_SDRAM\_Init allows the configuration and initialization of the SDRAM.
  - CAMERA\_Init allows the configuration of the camera module, DCMI registers, and DCMI parameters.
  - One of the two functions HAL\_DCMI\_Start\_DMA allowing the DCMI configuration in snapshot or in continuous mode, must be uncommented.

```
/* USER CODE BEGIN 2 */
LTDC_Init(FRAME_BUFFER, 0, 0, 320, 240);
BSP_SDRAM_Init();
CAMERA_Init(CAMERA_R320x240);
HAL_Delay(1000); //Delay for the camera to output correct data
Im_size = 0x9600; //size=320*240*2/4
/* uncomment the following line in case of snapshot mode */
//HAL_DCMI_Start_DMA(&hdcmi, DCMI_MODE_SNAPSHOT, (uint32_t)FRAME_BUFFER, Im_size);
/* uncomment the following line in case of continuous mode */
HAL_DCMI_Start_DMA(&hdcmi, DCMI_MODE_CONTINUOUS , (uint32_t)FRAME_BUFFER, Im_size);
/* USER CODE END 2 */
```



3. Insert the implementation of the new functions (called in the main () function), out of the main function, in the adequate space, indicated in bold below.

```
/* USER CODE BEGIN 4 */
void LCD GPIO Init(LTDC HandleTypeDef *hltdc, void *Params)
GPIO InitTypeDef gpio init structure;
/* Enable the LTDC and DMA2D clocks */
____HAL_RCC_LTDC_CLK ENABLE();
/* Enable GPIOs clock */
 HAL RCC GPIOE CLK ENABLE();
__HAL_RCC_GPIOG_CLK_ENABLE();
  HAL RCC GPIOI CLK ENABLE();
HAL RCC GPIOJ CLK ENABLE();
 HAL RCC GPIOK CLK ENABLE();
/*** LTDC Pins configuration ***/
/* GPIOE configuration */
gpio init structure.Pin = GPIO PIN 4;
gpio_init_structure.Mode = GPIO_MODE_AF PP;
gpio init structure.Pull = GPIO NOPULL;
gpio_init_structure.Speed = GPIO SPEED FAST;
gpio init structure.Alternate = GPIO AF14 LTDC;
HAL GPIO Init(GPIOE, &gpio init structure);
/* GPIOG configuration */
gpio init structure.Pin = GPIO PIN 12;
gpio_init_structure.Mode = GPIO_MODE_AF_PP;
gpio init structure.Alternate = GPIO AF9 LTDC;
HAL_GPIO_Init(GPIOG, &gpio_init_structure);
/* GPIOI LTDC alternate configuration */
gpio init structure.Pin = GPIO PIN 9 | GPIO PIN 10 | GPIO PIN 13 |
GPIO PIN 14 | GPIO PIN 15;
gpio init structure.Mode = GPIO MODE AF PP;
gpio init structure.Alternate = GPIO AF14 LTDC;
HAL_GPIO_Init(GPIOI, &gpio_init_structure);
/* GPIOJ configuration */
gpio_init_structure.Pin = GPIO_PIN_0 | GPIO_PIN_1 | GPIO_PIN_2 |
GPIO_PIN_3 | GPIO_PIN_4 | GPIO_PIN_5 | GPIO_PIN_6 | GPIO_PIN_7 | GPIO_PIN_5
| GPIO PIN 6 | GPIO PIN 7 | GPIO PIN 8 | GPIO PIN 9 | GPIO PIN 10 |
GPIO PIN 11 | GPIO PIN 13 | GPIO PIN 14 | GPIO PIN 15;
gpio_init_structure.Mode = GPIO_MODE_AF PP;
gpio init structure.Alternate = GPIO AF14 LTDC;
HAL_GPIO_Init(GPIOJ, &gpio_init_structure);
/* GPIOK configuration */
gpio init structure.Pin = GPIO PIN 0 | GPIO PIN 1 | GPIO PIN 2 |
GPIO_PIN_4 | GPIO_PIN_5 | GPIO_PIN_6 | GPIO_PIN_7;
gpio init structure.Mode = GPIO MODE AF PP;
gpio_init_structure.Alternate = GPIO_AF14 LTDC;
HAL GPIO Init(GPIOK, &gpio init structure);
/* LCD DISP GPIO configuration */
gpio_init_structure.Pin = GPIO_PIN_12; /* LCD_DISP pin has to be
manually controlled */
gpio init structure.Mode = GPIO MODE OUTPUT PP;
HAL GPIO Init(GPIOI, &gpio init structure);
/* LCD BL CTRL GPIO configuration */
gpio init structure.Pin = GPIO PIN 3; /* LCD BL CTRL pin has to be
manually controlled */
gpio_init_structure.Mode = GPIO MODE OUTPUT PP;
HAL GPIO Init(GPIOK, &gpio init structure);
static void LTDC_Init(uint32_t FB_Address, uint16_t Xpos, uint16_t Ypos,
uint16 t Width, uint16 t Height)
/* Timing Configuration */
hltdc.Init.HorizontalSync = (RK043FN48H_HSYNC - 1);
hltdc.Init.VerticalSync = (RK043FN48H VSYNC - 1);
hltdc.Init.AccumulatedHBP = (RK043FN48H HSYNC + RK043FN48H HBP - 1);
hltdc.Init.AccumulatedVBP = (RK043FN48H VSYNC + RK043FN48H VBP - 1);
hltdc.Init.AccumulatedActiveH = (RK043FN48H HEIGHT + RK043FN48H VSYNC +
RK043FN48H VBP - 1);
```



```
hltdc.Init.AccumulatedActiveW = (RK043FN48H WIDTH + RK043FN48H HSYNC +
RK043FN48H HBP - 1);
hltdc.Init.TotalHeigh = (RK043FN48H HEIGHT + RK043FN48H VSYNC +
RK043FN48H VBP + RK043FN48H VFP - 1);
hltdc.Init.TotalWidth = (RK043FN48H WIDTH + RK043FN48H HSYNC +
RK043FN48H HBP + RK043FN48H HFP - 1);
/* LCD clock configuration */
periph clk init struct.PeriphClockSelection = RCC PERIPHCLK LTDC;
periph clk init struct.PLLSAI.PLLSAIN = 192;
periph_clk_init_struct.PLLSAI.PLLSAIR = RK043FN48H_FREQUENCY_DIVIDER;
periph_clk_init_struct.PLLSAIDivR = RCC_PLLSAIDIVR_4;
HAL_RCCEx_PeriphCLKConfig(&periph_clk_init_struct);
/* Initialize the LCD pixel width and pixel height */
hltdc.LayerCfg->ImageWidth = RK043FN48H_WIDTH;
hltdc.LayerCfg->ImageHeight = RK043FN48H HEIGHT;
hltdc.Init.Backcolor.Blue = 0;/* Background value */
hltdc.Init.Backcolor.Green = 0;
hltdc.Init.Backcolor.Red = 0;
/* Polarity */
hltdc.Init.HSPolarity = LTDC HSPOLARITY AL;
hltdc.Init.VSPolarity = LTDC_VSPOLARITY_AL;
hltdc.Init.DEPolarity = LTDC_DEPOLARITY_AL;
hltdc.Init.PCPolarity = LTDC PCPOLARITY IPC;
hltdc.Instance = LTDC;
if(HAL LTDC GetState(&hltdc) == HAL LTDC STATE RESET)
LCD GPIO Init(&hltdc, NULL);
HAL LTDC Init(&hltdc);
/* Assert display enable LCD DISP pin */
HAL_GPIO_WritePin(GPIOI, GPIO_PIN_12, GPIO_PIN_SET);
/* Assert backlight LCD BL CTRL pin */
HAL GPIO WritePin (GPIOK, GPIO_PIN_3, GPIO_PIN_SET);
DrawProp[0].pFont = &Font24 ;
/* Layer Init */
layer_cfg.WindowX0 = Xpos;
layer cfg.WindowX1 = Width;
layer_cfg.WindowY0 = Ypos;
layer_cfg.WindowY1 = Height;
layer cfg.PixelFormat = LTDC PIXEL FORMAT RGB565;
layer_cfg.FBStartAdress = FB_Address;
layer_cfg.Alpha = 255;
layer_cfg.Alpha0 = 0;
layer cfg.Backcolor.Blue = 0;
layer_cfg.Backcolor.Green = 0;
layer cfg.Backcolor.Red = 0;
layer cfg.BlendingFactor1 = LTDC BLENDING FACTOR1 PAxCA;
layer_cfg.BlendingFactor2 = LTDC_BLENDING_FACTOR2_PAxCA;
layer_cfg.ImageWidth = Width;
layer cfg.ImageHeight = Height;
HAL LTDC ConfigLayer(&hltdc, &layer cfg, 1);
DrawProp[1].BackColor = ((uint32_t)0xFFFFFFF);
DrawProp[1].pFont = &Font24;
DrawProp[1].TextColor = ((uint32 t)0xFF000000);
uint8 t CAMERA Init(uint32 t Resolution) /*Camera initialization*/
uint8 t status = CAMERA ERROR;
/* Read ID of Camera module via I2C */
if(ov9655_ReadID(CAMERA_I2C_ADDRESS) == OV9655_ID)
camera_driv = &ov9655_drv;/* Initialize the camera driver structure */
CameraHwAddress = CAMERA I2C ADDRESS;
if (Resolution == CAMERA R320x240)
camera driv->Init(CameraHwAddress, Resolution);
HAL DCMI DisableCROP(&hdcmi);
status = CAMERA OK; /* Return CAMERA OK status */
}
```

else
{
 status = CAMERA\_NOT\_SUPPORTED; /\* Return CAMERA\_NOT\_SUPPORTED status \*/
}
return status;
}
/\* USER CODE END 4 \*/

### 8.3.2.9 Modifications in main.h file

Update main.h by inserting the frame buffer address declaration in the adequate space, indicated in bold below.

/\* USER CODE BEGIN Private defines \*/
#define FRAME\_BUFFER 0xC0000000
/\* USER CODE END Private defines \*/

At this stage, the user can build, debug, and run the project.

### 8.3.3 RGB data capture and display

To simplify this example, data are captured and displayed in RGB565 format (2 bpp). The image resolution is 320x240 (QVGA). The frame buffer is placed in the SDRAM. Camera and LCD data are located in the same frame buffer. The LCD displays then directly the data captured through the DCMI without any processing. The camera module is configured to output RGB565 data, QVGA (320x240).

The configuration of this example can be done by following the steps described in Section 8.3.2.

### 8.3.4 YCbCr data capture

This implementation example aims to receive YCbCr data from the camera module, and to transfer them to the SDRAM.

Displaying the YCbCr received data on the LCD (configured to display RGB565 data in the previous configuration) is not correct, but can be used for verification.

To display images correctly, YCbCr data must be converted into RGB565 data (or RGB888 or ARGB8888, depending on the application needs).

All the configuration steps signaled in Section 8.3.2 must be followed.

Some instructions must be added to obtain YCbCr data. Only the camera configuration has to be updated by adding:

- A table of constants allowing the configuration of camera module registers
- A new function used to configure the camera module by sending the register configuration through the I2C.



```
    Add the table containing the configuration of camera module registers in main.c,
below /* Private variables -----*/.
```

const unsigned char OV9655 YUV QVGA [ ][2]= { { 0x12, 0x80 },{ 0x00, 0x00 },{ 0x01, 0x80 },{ 0x02, 0x80 },{ 0x03, 0x02 },{ 0x04, 0x03 },{ 0x0e, 0x61 }, { 0x0f, 0x42 },{ 0x11, 0x01 },{ 0x12, 0x62 },{ 0x13, 0xe7 },{ 0x14, 0x3a },{ 0x16, 0x24 },{ 0x17, 0x18 }, { 0x18, 0x04 } },{ 0x19, 0x01 },{ 0x1a, 0x81 } ,{ 0x1e, 0x04 },{ 0x24, 0x3c },{ 0x25, 0x36 },{ 0x26, 0x72 }, { 0x27, 0x08 },{ 0x28, 0x08 },{ 0x29, 0x15 },{ 0x2a, 0x00 },{ 0x2b, 0x00 },{ 0x2c, 0x08 },{ 0x32, 0x24 }, { 0x33, 0x00 },{ 0x34, 0x3f },{ 0x35, 0x00 },{ 0x36, 0x3a },{ 0x38, 0x72 },{ 0x39, 0x57 },{ 0x3a, 0x0c },{ 0x3b, 0x04 },{ 0x3d, 0x99 },{ 0x3e, 0x0e },{ 0x3f, 0xc1 },{ 0x40, 0xc0} ,{ 0x41, 0x01 },{ 0x42, 0xc0 },{ 0x43, 0x0a },{ 0x44, 0xf0 },{ 0x45, 0x46 },{ 0x46, 0x62} ,{ 0x47, 0x2a },{ 0x48, 0x3c },{ 0x4a, 0xfc }, { 0x4b, 0xfc },{ 0x4c, 0x7f },{ 0x4d, 0x7f}, { 0x4e, 0x7f },{ 0x52, 0x28 },{ 0x53, 0x88 },{ 0x54, 0xb0 }, { 0x4f, 0x98 },{ 0x50, 0x98} ,{ 0x51, 0x00 },{ 0x58, 0x1a },{ 0x59, 0x85 },{ 0x5a, 0xa9 },{ 0x5b, 0x64 },{ 0x5c, 0x84 },{ 0x5d, 0x53 },{ 0x5e, 0x0e },{ 0x5f, 0xf0 },{ 0x60, 0xf0 },{ 0x61, 0xf0 },{ 0x62, 0x00 }, { 0x63, 0x00 }, { 0x64, 0x02 }, { 0x65, 0x20 }, { 0x66, 0x00 }, { 0x69, 0x0a },{ 0x6b, 0x5a },{ 0x6c, 0x04 }, { 0x6d, 0x55 },{ 0x6e, 0x00 },{ 0x6f, 0x9d },{ 0x70, 0x21 },{ 0x71, 0x78 },{ 0x72, 0x11 },{ 0x73, 0x01 }, { 0x74, 0x10 },{ 0x75, 0x10 } ,{ 0x76, 0x01 },{ 0x77, 0x02 },{ 0x7a, 0x12 },{ 0x7b, 0x08 },{ 0x7c, 0x15 }, { 0x7d, 0x24 },{ 0x7e, 0x45 },{ 0x7f, 0x55 },{ 0x80, 0x6a },{ 0x81, 0x78 },{ 0x82, 0x87 },{ 0x83, 0x96 }, { 0x84, 0xa3 },{ 0x85, 0xb4 },{ 0x86, 0xc3 },{ 0x87, 0xd6 },{ 0x88, 0xe6 },{ 0x89, 0xf2 },{ 0x8a, 0x24 }, { 0x8c, 0x80 }, { 0x90, 0x7d }, { 0x91, 0x7b }, { 0x9d, 0x02 }, { 0x9e, 0x02 },{ 0x9f, 0x7a },{ 0xa0, 0x79 }, { 0xa1, 0x40 },{ 0xa4, 0x50 },{ 0xa5, 0x68 },{ 0xa6, 0x4a },{ 0xa8, 0xc1 },{ 0xa9, 0xef },{ 0xaa, 0x92 }, { 0xab, 0x04 } ,{ 0xac, 0x80 },{ 0xad, 0x80 },{ 0xae, 0x80 },{ 0xaf, 0x80 },{ 0xb2, 0xf2 },{ 0xb3, 0x20 } ,{ 0xb4, 0x20 },{ 0xb5, 0x00 },{ 0xb6, 0xaf },{ 0xbb, 0xae },{ 0xbc, 0x7f },{ 0xbd, 0x7f } ,{ 0xbe, 0x7f },{ 0xbf, 0x7f },{ 0xc0, 0xaa },{ 0xc1, 0xc0 },{ 0xc2, 0x01 },{ 0xc3, 0x4e },{ 0xc6, 0x05 },{ 0xc7, 0x81 },{ 0xc9, 0xe0 },{ 0xca, 0xe8 },{ 0xcb, 0xf0 },{ 0xcc, 0xd8 },{ 0xcd, 0x93 }, { 0xcd, 0x93 }, { 0xFF, 0xFF } };

2. The new function prototype has to be inserted below /\* <code>Private function prototypes -----\*/</code>.

void OV9655\_YUV\_Init (uint16\_t );

3. The second step of modifications in main.c described in Section 8.3.2.8 has to be updated. Modify the main() function by inserting the following functions in the adequate space, indicated in bold below. One of the two functions allowing the DCMI configuration in snapshot or in continuous mode must be uncommented.

```
/* USER CODE BEGIN 2 */
BSP_SDRAM_Init();
CAMERA_Init(CameraHwAddress);
OV9655_YUV_Init(CameraHwAddress);
HAL_Delay(1000); //Delay for the camera to output correct data
Im_size = 0x9600; //size=320*240*2/4
/* uncomment the following line in case of snapshot mode */
//HAL_DCMI_Start_DMA(&hdcmi, DCMI_MODE_SNAPSHOT, (uint32_t)FRAME_BUFFER, Im_size);
/* uncomment the following line in case of continuous mode */
HAL_DCMI_Start_DMA(&hdcmi, DCMI_MODE_CONTINUOUS , (uint32_t)FRAME_BUFFER, Im_size);
/* USER CODE END 2 */
```

4. The third step of modifications in main.c described in Section 8.3.2.8 has to be updated by adding the new function implementation.

```
void OV9655_YUV_Init(uint16_t DeviceAddr)
{ uint32_t index;
for(index=0; index<(sizeof(OV9655_YUV_QVGA)/2); index++)
{ CAMERA_IO_Write(DeviceAddr, OV9655_YUV_QVGA[index][0],
OV9655_YUV_QVGA[index][1]);
CAMERA_Delay(1);
} }</pre>
```

### 8.3.5 Y only data capture

In this example, the camera module is configured to output YCbCr data format. By using the byte select feature on the DCMI side, the chrominance components (Cb and Cr) are ignored: only the Y component is transferred to the frame buffer in the SDRAM.



All the configuration steps signaled in Section 8.3.2 must be followed.

Some instructions must be added to obtain the Y only data. Only the camera and the DCMI configuration must be updated. To simplify this task, main.c must be modified as described in Section 8.3.4, but the second step of STM32CubeMX - DCMI control signals and capture mode configuration, or the static void

MX\_DCMI\_Init (void) function (this function is implemented in main.c) must be modified..

hdcmi.Instance = DCMI; hdcmi.Init.SynchroMode = DCMI\_SYNCHRO\_HARDWARE; hdcmi.Init.PCKPolarity = DCMI\_PCKPOLARITY\_RISING; hdcmi.Init.VSPolarity = DCMI\_VSPOLARITY\_HIGH; hdcmi.Init.HSPolarity = DCMI\_HSPOLARITY\_LOW; hdcmi.Init.CaptureRate = DCMI\_CR\_ALL\_FRAME; hdcmi.Init.ExtendedDataMode = DCMI\_EXTEND\_DATA\_8B; hdcmi.Init.ByteSelectMode = DCMI\_BSM\_OTHER; hdcmi.Init.ByteSelectStart = DCMI\_OEBS\_EVEN; hdcmi.Init.LineSelectMode = DCMI\_LSM\_ALL; hdcmi.Init.LineSelectStart = DCMI\_OELS\_ODD;

### 8.3.6 Resolution capture (YCbCr data format)

This implementation example aims to receive YCbCr data from the camera module, and to transfer them to the SDRAM. The captured image resolution is 1280x1024.

To display images correctly, YCbCr data must be converted into RGB565 data (or RGB888 or ARGB8888, depending on the application needs).

All the configuration steps details in Section 8.3.2 must be followed.

Some instructions must be added to obtain the YCbCr data. Only the DMA and the camera module configuration have to be updated.

#### **DMA** configuration

The DMA is configured as described in Section 6.4.9: DMA configuration for higher resolutions. The  $\tmbox{HAL}_DMA\_START$  function ensures this configuration because the image size exceeds the maximum allowed size for double-buffer mode.

Calling HAL\_DMA\_START ensures the division of the received frames to equal parts, and the placement of each part in one frame buffer. As explained, for the SXGA resolution, each frame is divided in 16 frame buffers. Each buffer size is equal to 40960 words.

For the buffers addresses,  $HAL_DMA_START$  ensures the placement of the 16 frame buffers in the memory. In this case, the address of the first frame buffer is 0xC0000000. The second address is then 0xC0163840 (0xC0000000 + (40960 \* 4)). The 16<sup>th</sup> frame buffer address is (0xC0000000 + 16 \* (40960 \* 4)).

At the end of each transfer, the DMA has filled one frame, an interrupt is generated, the address of the next buffer is calculated, and one pointer is modified as illustrated in Figure 47. DMA operation in high resolution case.

#### Camera module configuration

The new camera module configuration is done by adding:

- A table of constants allowing the configuration of camera module registers
- A new function used to configure the camera module by sending the register configuration through the I2C



To ensure that the camera module sends images having a YCbCr format, the CMOS sensor registers must be configured with the following steps:

```
1. Add the table containing the configuration of camera module registers in \tt main.c
```

```
below /* Private variables -----*/.
```

```
const unsigned char ov9655 yuv sxga[][2]= {
{ 0x12, 0x80 }, { 0x00, 0x00 }, { 0x01, 0x80 }, { 0x02, 0x80 }, { 0x03, 0x1b }, {
0x04, 0x03 }, { 0x0e, 0x61 },{ 0x0f, 0x42 },{ 0x11, 0x00 },{ 0x12, 0x02 },{
0x13, 0xe7 },{ 0x14, 0x3a },{ 0x16, 0x24 }, { 0x17, 0x1d },{ 0x18, 0xbd },{
0x19, 0x01 },{ 0x1a, 0x81 }, { 0x1e, 0x04 }, { 0x24, 0x3c }, { 0x25, 0x36 }
},{ 0x26, 0x72 }, { 0x27, 0x08 }, { 0x28, 0x08 },{ 0x29, 0x15 },{ 0x2a, 0x00
},{ 0x2b, 0x00 },{ 0x2c, 0x08 },{ 0x32, 0xff },{ 0x33, 0x00 },{ 0x34, 0x3d
},{ 0x35, 0x00 },{ 0x36, 0xf8 },{ 0x38, 0x72 },{ 0x39, 0x57 }, { 0x3a, 0x0c
},{ 0x3b, 0x04 },{ 0x3d, 0x99 }, { 0x3e, 0x0c },{ 0x3f, 0xc1 },{ 0x40, 0xd0
},{ 0x41, 0x00 },{ 0x42, 0xc0 },{ 0x43, 0x0a },{ 0x44, 0xf0 },{ 0x45, 0x46
},{ 0x46, 0x62 }, { 0x47, 0x2a }, { 0x48, 0x3c }, { 0x4a, 0xfc }, { 0x4b, 0xfc
},{ 0x4c, 0x7f },{ 0x4d, 0x7f },{ 0x4e, 0x7f },{ 0x52, 0x28 },{ 0x53, 0x88 }
},{ 0x54, 0xb0 },{ 0x4f, 0x98 },{ 0x50, 0x98 },{ 0x51, 0x00 },{ 0x58, 0x1a
},{ 0x58, 0x1a },{ 0x59, 0x85 },{ 0x5a, 0xa9 },{ 0x5b, 0x64 },{ 0x5c, 0x84
},{ 0x5d, 0x53 },{ 0x5e, 0x0e }, { 0x5f, 0xf0 }, { 0x60, 0xf0 }, { 0x61,
0xf0 }, { 0x62, 0x00 }, { 0x63, 0x00 }, { 0x64, 0x02 }, { 0x65, 0x16 }, { 0x66,
0x01 },{ 0x69, 0x02 },{ 0x6b, 0x5a }, { 0x6c, 0x04 }, { 0x6d, 0x55 }, {
0x6e, 0x00 },{ 0x6f, 0x9d },{ 0x70, 0x21 }, { 0x71, 0x78 },{ 0x72, 0x00 },{
0x73, 0x01 },{ 0x74, 0x3a },{ 0x75, 0x35 },{ 0x76, 0x01 },{ 0x77, 0x02 },{
0x7a, 0x12 },{ 0x7b, 0x08 }, { 0x7c, 0x15 }, { 0x7d, 0x24 },{ 0x7e, 0x45 },{
0x7f, 0x55 },{ 0x80, 0x6a },{ 0x81, 0x78 },{ 0x82, 0x87 },{ 0x83, 0x96 },{
0x84, 0xa3 },{ 0x85, 0xb4 }, { 0x86, 0xc3 },{ 0x87, 0xd6 },{ 0x88, 0xe6 },
{ 0x89, 0xf2 }, { 0x8a, 0x03 }, { 0x8c, 0x0d }, { 0x90, 0x7d }, { 0x91, 0x7b
}, { 0x9d, 0x03 }, { 0x9e, 0x04 }, { 0x9f, 0x7a }, { 0xa0, 0x79 }, { 0xa1,
0x40 }, { 0xa4, 0x50 }, { 0xa5, 0x68 }, { 0xa6, 0x4a }, { 0xa8, 0xc1 }, {
0xa9, 0xef }, { 0xaa, 0x92 }, { 0xab, 0x04 }, { 0xac, 0x80 }, { 0xad, 0x80 }, {
0xae, 0x80 },{ 0xaf, 0x80 },{ 0xb2, 0xf2 },{ 0xb3, 0x20 },{ 0xb4, 0x20 },{
0xb5, 0x00 }, { 0xb6, 0xaf }, { 0xbb, 0xae }, { 0xbc, 0x7f }, { 0xbd, 0x7f }, {
Oxbe, 0x7f }, { 0xbf, 0x7f }, { 0xc0, 0xe2 }, { 0xc1, 0xc0 }, { 0xc2, 0x01 },
{ 0xc3, 0x4e }, { 0xc6, 0x05 }, { 0xc7, 0x80 }, { 0xc9, 0xe0 }, { 0xca, 0xe8
}, { 0xcb, 0xf0 }, { 0xcc, 0xd8 }, {0xcd, 0x93} , { 0xFF, 0xFF } };
```

2. The new function prototype has to be inserted

below /\* Private function prototypes -----\*/ .

```
void OV9655 YUV Init (uint16 t );
```

3. The second step of modifications in main.c in this example is to update the main() function by inserting the following functions in the adequate space (indicated in bold below). One of the two functions allowing the DCMI configuration in snapshot or in continuous mode must be uncommented.

```
/* USER CODE BEGIN 2 */
BSP_SDRAM_Init();
CAMERA_Init(CameraHwAddress);
OV9655_YUV_Init(CameraHwAddress);
HAL_Delay(1000); //Delay for the camera to output correct data
Im_size = 0xA0000; //size=1280*1024*2/4
/* uncomment the following line in case of snapshot mode */
//HAL_DCMI_Start_DMA(&hdcmi, DCMI_MODE_SNAPSHOT, (uint32_t)FRAME_BUFFER,
Im_size);
/* uncomment the following line in case of continuous mode */
HAL_DCMI_Start_DMA(&hdcmi, DCMI_MODE_CONTINUOUS , (uint32_t)FRAME_BUFFER,
Im_size);
/* USER CODE END 2 */
```



4. The third step of modifications in main.c described in Section 8.3.2.8 has to be updated by adding the new function implementation below /\* USER CODE BEGIN 4 \*/.

```
void OV9655_YUV_Init(uint16_t DeviceAddr)
{
uint32_t index;
for(index=0; index<(sizeof(ov9655_yuv_sxga)/2); index++)
{
CAMERA_IO_Write(DeviceAddr, ov9655_yuv_sxga[index][0],
ov9655_yuv_sxga[index][1]);
CAMERA_Delay(1);
}</pre>
```

*Note:* In case of frame with RGB data format, the user can reduce the resolution to display the received images on the LCD\_TFT by using the resizing feature of the DCMI.

### 8.3.7 JPEG data capture

The OV9655 CMOS sensor embedded in the STM32F4DIS-Cam board does not support the compressed output data. This example is then implemented using OV2640 CMOS sensor, supporting the 8-bit format compressed data.

This example is based on the STM324x9I-EVAL (REV B) board embedding the OV2640 CMOS sensor (MB1066).

The compressed data (JPEG) must be uncompressed to have YCbCr data, and converted to RGB to be displayed, but this implementation example aims only to receive JPEG data through the DCMI, and to store them in the SDRAM.

This example is developed based on the DCMI example (SnapshotMode) provided within the STM32CubeF4 firmware, located in Projects\STM324x9I\_EVAL\Examples\DCMI\DCMI\_SnapshotMode. The provided example, aims to capture one RGB frame (QVGA resolution), and to display it on the LCD-TFT, having the following configuration:

• The DCMI and I2C GPIOs are configured as described in Section 8.3.2.

- The system clock runs at 180 MHz.
- SDRAM clock runs at 90 MHz.
- The DCMI is configured to capture 8-bit data width in hardware synchronization (uncompressed data).
- The camera module is configured to output RGB data images with QVGA resolution.

Based on this example, to be able to capture JPEG data, the user needs to modify the DCMI and the camera module configuration.

#### **DCMI** configuration

The DCMI needs to be configured to receive compressed data (JPEG) by setting the JPEG bit in DCMI\_CR. To set this bit, the user must simply add the instruction written in bold below in the stm324x9i\_eval\_camera.c file in uint8\_t BSP\_CAMERA\_Init(uint32\_t Resolution) (this function is called in main() to configure the DCMI and the camera module). The DCMI previous configuration is kept.

```
phdcmi->Init.CaptureRate = DCMI_CR_ALL_FRAME;
phdcmi->Init.HSPolarity = DCMI_HSPOLARITY_LOW;
phdcmi->Init.SynchroMode = DCMI_SYNCHRO_HARDWARE;
phdcmi->Init.VSPolarity = DCMI_VSPOLARITY_LOW;
phdcmi->Init.ExtendedDataMode = DCMI_EXTEND_DATA_8B;
phdcmi->Init.PCKPolarity = DCMI_PCKPOLARITY_RISING;
phdcmi->Init.JPEGMode = DCMI_JPEG_ENABLE;
```



#### Camera module configuration

The configuration of CMOS sensor (ov2640) registers must be inserted in the ov2640.c file.

```
const unsigned char OV2640 JPEG[][2]=
 { {0xff, 0x00}, {0x2c, 0xff}, {0x2e, 0xdf}, {0xff, 0x01}, {0x12,
0x80},{0x3c, 0x32},{0x11, 0x00},{0x09,0x02},{0x04, 0x28},{0x13,
0xe5},{0x14, 0x48},{0x2c, 0x0c},{0x33, 0x78},{0x3a, 0x33},{0x3b,
0xfb}, {0x3e, 0x00}, {0x43, 0x11}, {0x16, 0x10}, {0x39, 0x02}, {0x35,
0x88},{0x22, 0x0a},{0x37, 0x40},{0x23, 0x00},{0x34,
0xa0}, {0x36, 0x1a}, {0x06, 0x02}, {0x07, 0xc0}, {0x0d, 0xb7}, {0x0e,
\texttt{0x01}, \texttt{\{0x4c, 0x00\}, \{0x4a, 0x81\}, \{0x21, 0x99\}, \{0x24, 0x40\}, \{0x25, 0x40\}, \texttt{\{0x25, 0x40\}, \{0x25, 0x40\}, \{0x40\}, \{0x40
0x38}, {0x26, 0x82}, {0x5c, 0x00}, {0x63, 0x00}, {0x46, 0x3f}, {0x61,
0x70},{0x62, 0x80},{0x7c, 0x05}, {0x20, 0x80},{0x28, 0x30},{0x6c,
0x00},{0x6d, 0x80},{0x6e, 0x00},{0x70, 0x02},{0x71,0x94},{0x73,
0xc1},{0x3d, 0x34},{0x5a, 0x57},{0x4f, 0xbb},{0x50, 0x9c},{0xff,
0x00},{0xe5, 0x7f},{0xf9, 0xc0},{0x41, 0x24},{0xe0, 0x14},{0x76,
0xff}, {0x33, 0xa0}, {0x42, 0x20}, {0x43, 0x18}, {0x4c, 0x00}, {0x87,
0xd0},{0x88, 0x3f},{0xd7, 0x03},{0xd9, 0x10},{0xd3, 0x82},{0xc8,
0x08},{0xc9, 0x80},{0x7c, 0x00}, {0x7d, 0x00},{0x7c, 0x03},{0x7d,
0x48}, {0x7d, 0x48}, {0x7c, 0x08}, {0x7d, 0x20}, {0x7d, 0x10}, {0x7d,
0x0e},{0x90, 0x00},{0x91, 0x0e},{0x91, 0x1a},{0x91, 0x31},{0x91,
0x5a},{0x91, 0x69},{0x91, 0x75},{0x91, 0x7e},{0x91, 0x88},{0x91,
0x8f},{0x91, 0x96}, {0x91, 0xa3},{0x91, 0xaf},{0x91, 0xc4},{0x91,
0xd7},{0x91, 0xe8},{0x91, 0x20},{0x92, 0x00},{0x93, 0x06},{0x93,
0xe3},{0x93, 0x05},{0x93, 0x05},{0x93, 0x00},{0x93, 0x04},{0x93,
0x00}, {0x93, 0x00}, {0x00}, 
0x00},{0x93, 0x00},{0x96, 0x00},{0x97, 0x08},{0x97, 0x19},{0x97,
0x02},{0x97, 0x0c},{0x97, 0x24},{0x97, 0x30},{0x97, 0x28},{0x97,
0x26},{0x97, 0x02},{0x97, 0x98},{0x97, 0x80},{0x97, 0x00},{0x97,
0x00},{0xc3, 0xed},{0xc5, 0x11},{0xc6, 0x51},{0xbf, 0x80},{0xc7,
0x00},{0xb6, 0x66},{0xb8, 0xA5},{0xb7, 0x64},{0xb9, 0x7C},{0xb3,
0xaf},{0xb4, 0x97},{0xb5, 0xFF},{0xb0, 0xC5},{0xb1, 0x94},{0xb2,
0x0f},{0xc4, 0x5c},{0xc0, 0xc8},{0xc1, 0x96},{0x86, 0x1d},{0x50,
0x00},{0x51, 0x90},{0x52, 0x18}, {0x53, 0x00},{0x54, 0x00},{0x55,
0x88},{0x57, 0x00},{0x5a, 0x90},{0x5b, 0x18}, {0x5c, 0x05},{0xc3,
0xed}, {0x7f, 0x00}, {0xda, 0x00}, {0xe5, 0x1f}, {0xe1, 0x77}, {0xe0,
0x00},{0xdd, 0x7f},{0x05, 0x00},{0xFF, 0x00},{0x05, 0x00},{0xDA,
0x10},{0xD7, 0x03},{0xDF, 0x00},{0x33, 0x80},{0x3C, 0x40}, {0xe1, 0x77},
{0x00, 0x00} };
```

To modify the camera module registers, the previous table must be sent to the camera through the I2C. In ov264 0.c, in void ov2640\_Init(uint16\_t DeviceAddr, uint32\_t resolution), replace:

```
case CAMERA_R320x240:
{
for(index=0; index<(sizeof(OV2640_QVGA)/2); index++)
{
CAMERA_IO_Write(DeviceAddr, OV2640_QVGA[index][0],
OV2640_QVGA[index][1]);
CAMERA_Delay(1);
}
break;
}</pre>
```

#### by

```
case CAMERA_R320x240:
{
for(index=0; index<(sizeof( OV2640_JPEG)/2); index++)
{
CAMERA_IO_Write(DeviceAddr, OV2640_JPEG[index][0],
OV2640_JPEG[index][1]);
CAMERA_Delay(1);
}
break;
}</pre>
```



## 9 Supported devices

To know if a CMOS sensor (a camera module) is compatible with the DCMI or not, the user must check the following points in the CMOS sensor specifications:

- Parallel interface (8-, 10-, 12-, or 14-bit)
- Control signals (VSYNC, HSYNC, and PIXCLK)
- Supported pixel clock frequency output
- Supported data output

There is a wide range of camera modules and CMOS sensors that are compatible with the STM32 DCMI. The table below lists some of them.

CMOS sensor	Camera module	Formats	Parallel interface
MT9D111	ArduCAM 2 megapixels	RGB, YCbCr, JPEG	10-bit
MT9P111	5 megapixels	RGB, YCbCr, JPEG	8-bit
NT99141	ArduCAM 1 megapixel	RGB, YCbCr, JPEG	8-bit
OV2640	ArduCAM 2 megapixels	RGB, YCbCr, JPEG	8-bit, 10-bit
OV3660	3 megapixels	RGB, YCbCr	8-bit, 10-bit
OV5640	ArduCAM 5 megapixels	RGB, YCbCr, JPEG	8-bit, 10-bit
OV5642	ArduCAM 5 megapixels	RGB, YCbCr, JPEG	8-bit, 10-bit
OV9655	ArduCAM 1.3 megapixels	RGB, YCbCr	8-bit
S5k4ECGX	5 megapixels	RGB, JPEG	10-bit
S5k5CAGA	3 megapixels	RGB, JPEG	10-bit

#### Table 15. Examples of supported camera modules

## 10 Conclusion

The DCMI represents an efficient interface to connect the camera modules to the STM32 MCUs supporting high speed, high resolutions, and a variety of data formats/widths.

Together with the variety of peripherals and interfaces integrated in STM32 MCUs and benefiting from the STM32 smart architecture, the DCMI can be used in large and sophisticated imaging applications.

This application note covers the DCMI across the STM32 MCUs, providing all the necessary information to correctly use the DCMI, and to succeed in implementing applications starting from the compatible camera module selection to detailed examples implementation.



## **Revision history**

#### Table 16. Document revision history

Date	Version	Changes
3-Aug-2017 1		Initial release.
17-Oct-2022	2	Updated:         • Table 1. Applicable products         • Table 2. DCMI and related resources availability         • Section 3.2: DCMI in a smart architecture with all new products         • Table 6. DCMI and camera modules on STM32 boards         • Section 5.6.4: YCbCr, Y only         • Section 5.8: Image resizing (resolution modification)         • Table 7. DCMI operation in low-power modes         • Section 6.4.1: DMA configuration for DCMI-to-memory transfers         • Table 8. DMA stream selection across STM32 devices         • Section 6.4.4: DMA_SxNDTR/DMA_CNDTRx/GPDMA_CxBR1 register         • Table 13. Maximum data flow at maximum DCMI_PIXCLK         • Table 14. STM32Cube DCMI examples         • Section 8.3.2: Configuration of common examples         • Table 15. Examples of supported camera modules
24-Feb-2023	3	Updated:         • Table 1. Applicable products         • Table 2. DCMI and related resources availability         • Figure 7. DCMI slave AHB2 peripheral in the STM32F4         • Figure 8. DCMI slave AHB2 peripheral in the STM32F7         • Figure 9. DCMI slave AHB2 peripheral in the STM32H723/733, STM32H743/753, STM32H742, STM32H725/735, STM32H730, and STM32H750 devices         • Figure 10. DCMI slave AHB2 peripheral in the STM32H745/755 and STM32H747/757 devices         • Figure 11. DCMI slave AHB2 peripheral in the STM32H7A3/B3         • Figure 12. DCMI slave AHB2 peripheral in the STM32H7A3/B3         • Figure 13. DCMI slave AHB2 peripheral in the STM32L496/4A6         • Figure 13. DCMI slave AHB2 peripheral in the STM32L496/4A6         • Figure 17. DCMI block diagram: example of 12-bit data width         • Section 6.4: DMA configuration         • Table 9. DMA stream selection across STM32 devices         • Table 13. Maximum data flow at maximum DCMI_PIXCLK         • Section 3.2.4.3: STM32H7A3/7B3 devices         Added:         • Section 3.2.8: STM32H5 system architecture         • Section 3.2.7: STM32U5 system architecture
20-Nov-2024	4	Document updated to add STM32H523/533 line and STM32N6 series to the scope of this document.



Date	Version	Changes
Date	Version	Changes         Updated:         • Table 1. Applicable products: add new products in the scope of the document         • Section 2.1: Basic imaging concepts: title updated, and typos corrected inside the section         • Section 3.1: DCMI availability and features across STM32 MCUs: Table 2         • Section 3.2: DCMI in a smart architecture         • Section 3.2.4.1: STM32H7x3, STM32H742, STM32H725/735, STM32H730, and STM32H750 devices         • Section 3.2.5: STM32L4 system architecture         • Section 3.2.6: STM32L4+ system architecture including Figure 13. DCMI slave AHB2 peripheral in the STM32L4+         • Section 3.2.7: STM32U5 system architecture         • Section 3.2.8: STM32H7S3I-EVAL and STM32U575I-EVAL in Table 6. DCMI and camera modules on STM32 boards         • Figure 17. DCMI block diagram: example of 12-bit data width         • Section 5.6: Data formats and storage         • Section 5.8: Image resizing (resolution modification)         • Table 7. DCMI operation in low-power modes
		<ul> <li>camera modules on STM32 boards</li> <li>Figure 17. DCMI block diagram: example of 12-bit data width</li> <li>Section 5.6: Data formats and storage</li> <li>Section 5.6.4: YCbCr, Y only</li> <li>Section 5.8: Image resizing (resolution modification)</li> </ul>
		<ul> <li>Section 6.4.3: DCMI channel and stream configuration including Table 9</li> <li>Section 6.4.5: FIFO and burst transfer configuration</li> <li>Section 6.4.7: Circular mode for low resolution in continuous capture</li> <li>Section 6.4.8: Double-buffer mode for medium resolutions (snapshot or continuous capture)</li> <li>Section 7.2: Performance</li> <li>Section 8.1: DCMI use cases</li> <li>Added:</li> </ul>
		Section 3.2.9: STM32N6 system architecture



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